

Another EMC resource from EMC Standards

Good EMC Engineering Practices in the Design and Construction of Industrial Cabinets



### **Good EMC Engineering Practices** in the Design and Construction of Industrial Cabinets

















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#### **REO UK LTD**

# 1 Introduction and background

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# 1.1 The financial need for these good EMC engineering practices

Because of the complexity of modern industrial instrumentation and control products and systems, it is necessary, for commercial and financial reasons, to control electromagnetic interference (EMI). Added to this is the regulatory requirement for the suppliers of products and systems, and owners of premises and sites in the European Union, to comply with the electromagnetic compatibility (EMC) Directive [1], especially the very specific requirements in the new EMC Directive [1] for the use of good EMC engineering practices [2].

This guide addresses the *practical* issues of designing and assembling industrial cabinets to better control EMI, and to help achieve EMC Directive compliance. For information on other EMI and EMC issues, such as management, testing, legal, and theoretical background see [2], [3], [4] and [5].

shields at only one end) are now very bad technologies in industry means that some wired/wireless data communications. The practices, but they are all well-proven and internationally standardised good modern EMC engineering practices at the time of writing. EMC is a rapidly developing field, perfectly adequate in the 1960s (such as might contradict established or traditional single-point earthing, and bonding cable because of the rapid pace of progress in Some of the techniques described here electronics, computing, software, power EMC techniques that might have been control (e.g. variable speed AC motor EMC practice indeed. All professional drives), radiocommunications and rapidly increasing use of these

engineers have a duty (professional, ethical, and legal) to apply the latest and best knowledge and practices in their work

Remember that safety is always paramount, and should not be compromised by any EMC techniques. A typical example of such a compromise is fitting EMI filters that cause high earthleakage currents that increase safety risks.

safety [6] or the industry standards derived safety (including during faults, foreseeable techniques described here are often used from it (such as [7] and [8]), or with safety Directive [9] and Machinery Directive [10]. possibly have implications for functional sufficient to achieve adequate safety risk almost certainly not achieve compliance Safety', a lot more is involved that is not malfunctions in electronic circuits could extremes) - merely meeting the EMC standards will almost certainly not be levels. Such an approach would also with the basic standard on functional regulations such as the Low Voltage to help achieve 'EMC for Functional understand that - where errors or misuse, overload, or environmental Although the design and assembly Directive and its harmonised EMC covered by this guide - for more However, it is very important to nformation on this, visit [11].

### 1.2 These techniques suit a wide range of applications

This guide is concerned with industrial instrumentation and control, but the laws of physics (hence EMC) apply to all electrical and electronic assemblies and systems, regardless of their application, in exactly the same way as they do to industrial cabinets. An Amp is still an

MHz is still a MHz regardless of function or written and illustrated this guide makes the Amp, a microvolt still a microvolt, and a application. I hope that the way I have techniques it describes easy to apply assemblies are being designed and wherever electrical and electronic constructed.

#### 1.3 EM phenomena and test standards

phenomena arise, and how they can cause International standards developed by the REO (UK) Ltd have published a series of devices and circuits and the applications 17 EMC Guides [4], which describe how problems for electrical and electronic they are used in. They then go on to the various electromagnetic (EM) describe the European EMC test EC, and how to test using them. standards, which are based on

Many companies do their own EMC testing the suitability of supplier's products, design However, they still have value in assessing standards. There are many easier, quicker problem-solving, checking workmanship and less costly ways to do EMC testing, according to European or International standards and other QA activities. For but they are less accurate and not as useful for proving legal compliance. and development, fault-finding and more on low-cost testing, see [12].

laboratory, with its carefully-controlled EM to be tested in the normal way. Examples time/cost or where equipment is too large environments, and can be used to save On-site test methods exist for testing of on-site methods that can be good enough to support a claim of EMC equipment outside of an EMC test compliance are given in [13].

#### 1.4 Some basic EMC theory (with almost no maths)

guide, and many practicing engineers would find it very tedious anyway. So I suggest echniques, and does not try to explain why needed, but trying to convey the theoretical article, and then reading their references if engineers vulnerable to special situations you still need more background. But here understanding required to devise special reading the references at the end of this are a few of the reasons why these EMC This guide focuses on practical tips and echniques is outside the scope of this where an unusual approach may be hey work. This approach can leave techniques are needed:

- employ a wide band of frequencies from MHz). For them to operate correctly and to achieve EMC it may be necessary to range by using EMC techniques in their even up to several GHz (thousands of audio up to at least 100 MHz, maybe control some or all of their frequency digital, switch-mode, and wireless - All modern electronics – especially cabling and assemblies, and in the cabinets that house them.
- (usually much less), and so can't provide voltage at frequencies above a few MHz impedance at frequencies above a few reactance of  $2\pi fL$  ohms at frequency fcoloured insulation) cannot be used to µH/metre for an ordinary wire (e.g. a nductance. Inductance (L) is typically green/yellow insulated wire), giving a provide an effective circuit reference (e.g. 63 Ω/m at 10MHz). As a result, wires (even ones with green/yellow MHz, caused by skin effect (which ncreases their resistance) and All conductors have significant any EMI control.

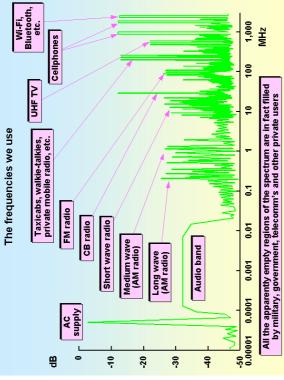
- can be used to reduce this effect, but it given in MHz. This is a common cause one end) can make the problem worse. proportion of the power and/or signals than one-tenth of a wavelength  $(\lambda/10)$ case where the conductors are longer incorrectly (e.g. shield bonded at only of EM emissions problems. Shielding All conductors – such as metalwork, at the highest frequency of concern. accidental antennas', and so leak a is never 100% effective and if done The wavelength  $\lambda = 300/f$  when f is environment. This is especially the wires and cables - make good they carry into their external
- 'accidental antennas', and so pick-up a highest frequency of concern. This is a one end) can make the problem worse. (immunity) problems. Shielding can be conductors are longer than  $\lambda/10$  at the incorrectly (e.g. shield bonded at only This is especially the case where the All conductors - such as metalwork, signals and power they are carrying. proportion of the EM energy in their common cause of EM susceptibility used to reduce this effect, but it is voltage and current noise into the external environment and so add never 100% effective and if done wires and cables - make good
- related to their dimensions and method fact, they become accidental antennas effective circuit reference voltage - in called 'earths' or 'grounds' - become of construction. Above this frequency frequencies they cannot provide EMI All conductive structures - typically control - and may even add to EMI ineffective above some frequency they no longer provide a stable or instead of 'grounds'. At such problems.

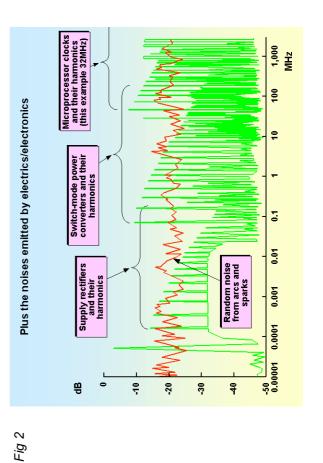
can cause the electrical energies they carry which show how the typical wire and cable antennas' are illustrated in Figures 1 - 3, (whether as signals or power) to interfere engths inside cabinets (0.5 to 3 metres) with the radio spectrum that is vital for The problems caused by 'accidental proadcasting and communications.

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bonding conductor (the green/yellow wire in engineering, leading directly to a great deal common bonding network (CBN, for a site); of confusion, delay and unnecessary extra electrode that is buried in the soil under or around a site. This guide will try to take its protective bonding network (for a cabinet); shielded (screened) enclosure; protective much misused in electrical and electronic mains cables, used for safety purposes); explicit terms such as: chassis or frame; own advice and use more accurate and costs. I strongly recommend that these The words 'earth' and 'ground' are very referring to an actual earth or ground words are never used, except when and of course, Reference.

called the RF Reference, Reference Plane, RF Common, or other terms such as 'EMC operation and good control of EMI and the As has been implied above, correct circuit requencies above 150kHz. In some other publications the Reference is sometimes range of frequencies we need to control, understand how to design and create a Reference that is effective over the full achievement of EMC requires that we especially radio frequencies (RF) -Earth' or 'EMC Ground'. The RF Reference itself must have very low of the capacitors in any EMI filters. The only enough impedance is a metal mesh, ideally a metal sheet, which is why RF References impedance over the frequency range to be controlled, much lower than the impedance kind of structure that can achieve a low are often called Reference Planes.





Length that makes a perfect 'accidental antenna' (3/4) 1,000 MHz 100 Metalwork and other conductors are also 'accidental antennas', in which case the lines above represent their longest '3-D diagonal' dimension All conductors are 'accidental antennas' 9 Length that makes inefficient antenna 5 0.01 Usually negligible antenna effects 0.00 0.00001 0.0001 Metres 000 9 0.0 Fig 3

might be used to connect the circuit to the RF Reference suffer from inductance and closer than  $\lambda/10$  at the highest frequency A circuit's RF Reference must always be physically close to the circuit that relies less, e.g. < 30mm for frequencies up to 100MHz). This is because of all of the upon it for operation or EMC - much to be controlled (ideally  $\lambda/100$  or even conductors, including large pieces of 'accidental antenna' effects at longer metal with negligible resistance, that distances.

A metal box of whatever size can be used than  $\lambda/10$  – to one of its metal surfaces. environment, but it can only be used as to shield a circuit from its external EM the RF Reference for that circuit if the circuit is close enough - much closer

#### 1.5 Don't rely solely on CEmarked electronics

Don't rely solely on using CE-marked

ndividually.

and products used in the construction of a cabinet are all CE marked, the cabinet as assumes that as long as the components components to assemble a cabinet. The Directives - has no technical or legal a whole will comply with all relevant 'CE + CE = CE' approach - which ustification. Experience all over the world shows that it even when all the components used in the manufacturers use when CE marking their items supplied by other manufacturers to can compromise the EMC of the cabinet, products, and warning of the pitfalls that or the system or installation it is used in, cabinet have excellent EMC compliance constructed from CE-marked electronic into this issue in detail, showing how to EMC standards when tested. [14] goes actually meet the relevant harmonised spot many of the tricks that some is very rare indeed, for a cabinet

Fig 1

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### 1.6 An overall EMC procedure

A procedure that will manage EMC to achieve reliable performance and legal compliance for industrial cabinets and similar will generally require:

- Assessing the intended operational environment for any EM disturbances, whether conducted or radiated, that might threaten the operation of the new cabinet. See [15] for more information on doing this.
- Assessing the intended application for the sensitivity of other electronic equipment that might be present, to the EM emissions from the new cabinet and its cables.
- Understanding all of the EMC regulatory requirements, for both emissions and immunity, see [2] [4] and [5].
- beriving an EMC specification for the cabinet and its cables (usually based around the basic IEC EMC test standards for emissions, such as CISPR 22, and immunity, such as the IEC 61000-4 series, see [4]).
- Choosing third-party electrical and electronic units that are known to have the EMC performance required to meet specifications derived from the above steps. This means checking their test reports and QA systems, as discussed in [14].
- Following the electronic unit suppliers' reasonable EMC instructions.
- Applying the EMC techniques described in this guide.
- Checking that the EMC techniques have been correctly applied in assembly by inspection and simple tests (see the lowcost EMC test techniques in [12]).

 Applying the appropriate compliance procedures under the old or new EMC Directives [1] [2]. EMC testing techniques are described in [4] and [12]. Useful information on the above procedures can be found in [16], which, despite its title, is of general relevance to systems and installations of all types and the products used in them.

#### 1.7 Following good EMC practices

In the kind of EM environments covered by the generic industrial EMC test standards EN 61000-6-2 and -4, most EMC problems can be solved by:

- Taking care to only utilise electrical/electronic that have proven good EMC performance [14] when tested to those standards or tougher ones
- Obtaining and fully applying their supplier's EMC instructions in design and construction
- Taking account of the build-up of emissions caused by having multiple units [17]

Even so, it is still advisable to employ good EMC practices wherever the units' suppliers provide no EMC instructions, or to help resolve conflicts between different units' EMC instructions.

However, most normal EM environments are worse than the ones described by any of the IEC or EN EMC test standards, because they specifically do not cover the situation where portable radio transmitters are used nearby — which is now commonplace in all environments (including industrial), and cannot be controlled without very stringent security measures. The standards also ignore a number of other EM environmental

situations that can easily occur. So in almost all real-life industrial situations, in and especially where the EM environment spris more extreme than usual, the use of the good EMC practices can be very errimportant indeed for preventing costly lost te production due to interference problems.

Good EMC practices in the construction of electrical and electronic assemblies have been known for decades, and are continually evolving to cope with the increasing frequencies being generated by modern electronic technologies, especially digital processing, switch-mode power conversion, and wireless voice and data communications. Relevant standards and public-domain documents on good EMC practices include [18] [19] [20] [21] and [22], and there are a number of guides to good practices produced by companies that sell industrial components, such as [23] [24] and [25].

Good EMC practices are often different from traditional electrical assembly and installation practices, and in some long-established industries large amounts of money and time are still needlessly wasted by fixing EMC problems with systems and installations arising during operation, instead of by design, because of an apparent reluctance to learn about EMC or modern techniques. It is often the case that operational problems aren't recognised as being EMC-related for some time, and even then take a long time to fix.

Part of good EMC practice is to follow the EMC instructions provided by the manufacturers of the electronic units that are to be used — but only where these are reasonable and don't conflict with what is written in this guide, or with each other. Where manufacturers' instructions differ or conflict, EMC expertise is

needed. For example, some suppliers of industrial components and modules specify that shielded cables must have their shields bonded to 'earth' at only one end, and they often provide a screwterminal for that purpose. While this may some special cases, it will generally prevent typical industrial cabinets from passing their emissions and/or immunity tests and will therefore generally lead to inaccurate or unreliable operation as well as non-compliance with legal requirements.

Such poor EMC instructions are mostly due to a lack of knowledge and/or poor design of the electronic circuits used for the inputs and outputs. They are usually written by companies who have not tested emissions and immunity, or not tested them properly, or tested them using unrealistic set-ups. They slavishly repeat the bad instructions in their manuals, believing them to be good EMC practice because they were told so 30 years or more ago.

Good EMC practices should generally be followed for all industrial cabinets, to help the purchased electrical and electronic items achieve the EM performance they are capable of, and to help EM mitigation measures like filtering, shielding and transient overvoltage suppression, function correctly. These techniques require additional effort and skill in design, but generally cost little and add very little time in assembly.

### 1.8 Communicating good EMC techniques within a company

Many companies have problems in turning the intentions of their designers into the constructions assembled by their assembly staff. Nowhere is this more

evident than in EMC, where apparently small variations in cable length or route, or component placement, can make huge differences.

Whereas in serial manufacture there is (hopefully) time allowed for what is constructed to be compared with what was designed and any differences iterated out — in custom engineering, designs need to be translated into products and systems without errors at the first attempt if a company is to maximise its profits and be successful.

So it is important — to save time and money — that companies find ways to communicate the necessary EMC assembly techniques to their assembly personnel. This generally means that the various construction techniques need to be documented as Work Instructions under a QA system, and then referenced by the designers on their drawings wherever they need to be applied. A number of industrial cabinet manufacturers have used the graphics used in this guide as part of their Work Instructions, and the author will be pleased to provide any such company with these graphics for such purposes, on

#### 2.1 Introduction to RF References

All industrial cabinets that contain two or more items of interconnected electronics (e.g. a variable-speed motor drive and its separate EMI filter, a PLC and a 24VDC power supply) should use an RF Reference to help control EMC, which can usually be created using the existing cabinet metalwork. This section describes techniques for creating RF References with useful EM performance from ordinary (unshielded) cabinet metalwork. A later section will describe the good EMC practices associated with shielded

At frequencies above a few MHz, only a highly conductive area or volume can achieve a reliable RF Reference. But an RF Reference is only of any use if it is a *local* one. 'Local' in this context means that the cables, devices and circuits should remain close to the surface of the Reference at all times, with a spacing that is less than  $\lambda/10$  at the highest frequency of concern (e.g. closer than 75mm at 400MHz, a typical walkie-talkie transmitting frequency). Much closer spacing gives much improved EM performance.

Where a metal chassis (ideally free from joints and perforations), metal cabinet, or metal enclosure is used the walls, rear, top, bottom, or door could be used as local RF References. Industrial cabinets often mount their electrical, electronic and other units on a metal backplate, or in a frame or cage for plug-in modules or printed-circuit cards. The metal support structures nearest to the electronics, such as backplates or card cages, should always form part of their local RF References and have multiple metal-to-metal bonds to adjoining metal structures.

### 2.2 Ineffectiveness of wires, straps and braids

As was discussed earlier, green/yellow wires or braid straps to a single point (sometimes called a 'star point') are ineffective at providing an RF Reference at frequencies above a few hundred kHz or so, depending on their length.

Even where electronic units (such as low-frequency analogue processing) do not employ or emit RF frequencies, the semiconductors in it will happily demodulate and intermodulate any RF noise in their circuits, causing immunity problems, unless their manufacturers have taken great care in their EMC design. Even DC and low-frequency analogue electronics need to employ good EMC practices.

### 2.3 Highly-conductive metal plating required, with no polymer passivation

common use today. Non-conductive paint, with a highly conductive metal plating that and then to prevent the corrosion that can involving local removal of paint or plastic), occur because the protective coating has effectiveness at high frequencies. Where he inductance of bonds and reduce their painted or plastic-coated surfaces are to local RF References if they are finished and lifecycle of the cabinet (see section is suitable for the physical environment 6). Only metal surface-to-metal surface effectively at the highest frequencies in plastic coatings, or anodising, increase It is easiest to use metal structures as be bonded to, care must be taken to achieve a good bond at RF (usually bonds have any chance of working

manufacturers in recent years, to help with mild steel, but sometimes thinner plating is become the standard for almost all cabinet n the case of industrial cabinets fitted with and avoid polymer passivation completely. can ruin RF-bonding properties. It is often claimed that polymer passivation is easily punctured by modest pressure from metal to standardise on metalwork that relies on through the polymer film it is much better parts such as the nuts and bolts typically used in electronic assembly. However, it backplates, zinc-plated backplates have RF-bonding and EMC. Heavy zinc or tin gaskets, and since they would not apply good metal plating to prevent corrosion, passivation is a thin plastic coating and plating is the best conductive finish for passivation layer. Unfortunately, the might prove necessary to use EMC sufficient contact pressure to break used with an additional polymer

inch rack-mounting system), or backplates equipment (for example the traditional 19cabinet. Any metal part in a cabinet that is cabinets used in the food, pharmaceutical (skin) is applied. These may be fitted with potential 'accidental antenna' as shown in consist of frames to which metal cladding function usefully as an RF Reference we must RF-bond them together all over the References, but most industrial cabinets cabinets consist of many metal parts all Reference, including hinged doors, is a for mounting DIN rails and/or chassisand other industries where hygiene is screwed together, and to make them not RF-bonded to form part of the RF important. These make excellent RF shelves for mounting large items of Some industrial cabinets are seamwelded, such as the stainless-steel mounted' units or modules. These Figure 3.

### 2.4 Making effective RF bonds

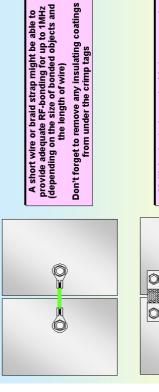
important issues being the achievement of Figures 4 and 5 show the principles of RFbonding between two sheets of metal, the sufficiently low RF impedances in the bonds themselves, and the maximum spacing between the bonding points.

Where a metal mesh is being used instead of a metal sheet or other solid metal part, it moderately effective RF Reference up to a mesh spacing gives the Reference a better frequency of 15/l MHz (l in metres). Closer Reference, the same techniques apply to Although Figures 4 and 5 show two metal any metal parts, and in three dimensions. sheets being bonded to form a larger RF RF performance at any frequency up to can only be relied upon to act as a

course it depends upon the frequency, and metal bonds used to connect metal parts Figures 6 and 7 show details of metal-totogether to create RF Reference planes. Any other kinds of bonds, including short impedance RF Reference, if the highest braid straps or even bond wires may be frequency that is to be controlled is no wide braid straps, are very inferior to metal-to-metal bonds - although of able to provide a sufficiently lowmore than a few hundred kHz.

is not an ideal method (although it is much 'spiky' washers and screw threads for RFmight be all that can be achieved - but it insulating finish, such as paint, anodising performance of an existing cabinet, this better than using wires or braid bonds). or even a polymer passivation coating. Figure 6 shows the use of aggressive bonding two metal items that have an When trying to improve the EM

Bonding sheet metal parts with wires or braid straps to create an RF Reference (not very good for >1MHz) Fig 4



the length of wire)

Multiple short wires or braid straps spread along a seam might be able to provide adequate RF-bonding for up to 30MHz (depends on the size of bonded objects, number, positions, lengths of wire, etc.)

Don't forget to remove any insulating coatings from under the crimp tags

0

0

0

Bonding sheet metal parts with metal-to-metal bonds at fixing points to create an RF Reference (much better)

Fig 5

100MHz, all of its metal parts should be metal-to-metal bonded at least every 150mm (6 inches) all along all of their joints bonding performance – but to be useful the overlap distance needs to be greater than 50% A large overlap at the seam helps improve RF (Overlaps don't have to be flat, they can go E.g. for an RF Reference to be useful up to Overlapped metalwork with metal-to-metal fixings every 15/f metres maintains a reasonably effective RF Reference up to f of the pitch of the metal-to-metal fixings (f=frequency in MHz) around corners) Metal-to-metal fixings, spot-welds, etc. 8 8 8 8

Fig 6

Note: bond shown partially assembled forming part of the RF Reference Metal sheets or structures Screw-threads or spiky washers are not ideal for RF-bonding Anti-vibration device (washer or other method) In this example, the self-tapping screw's cutting threads provide the RF bond – <u>not</u> a good method Insulating metal finishes (e.g. paint, anodising, polymer passivation)

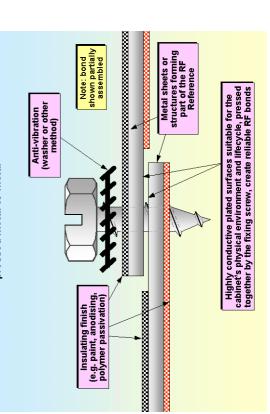
As mentioned earlier, it is much better to design cabinets in the first place to use conductively-plated metal parts throughout, with no paint or insulating finishes applied. Then the very best and most reliable RF bonds can be achieved by using the fixing screws to press the conducting metal surfaces together. Steel (apart from stainless) and aluminium are unsuitable materials on their own, they always develop a high resistance surface through oxidation, so always need to be tin plated or alochromed, or some other low resistance corrosion-proof finish.

The RF Reference in '19 inch' rack - mounting cabinets can be improved by making sure that the front panels of all the racked equipment make metal-to-metal bonds to the cabinet frame at their mounting points (sometimes called rack mounting ears). Typical mounting ears are made of anodised aluminium, and because anodising is a very tough insulator

they provide no RF-bonding. It is much better to use ears with highly conductive plating, screwed into caged nuts in a frame that also has highly conductive plating. The 19 inch spacing between the bonds at both sides of the front panels means that the RF Reference thus created has a low impedance up to about 20MHz – to control higher frequencies more effectively it would help to create RF bonds along the long edges of the front panels, to the shelves above and below.

A variety of special EMC tapes are available from companies such as 3M, which can be used to provide a good high-conductivity bonding surface (usually tin) instead of relying on plating. Some types have a top layer of masking tape so that the metal parts can be painted, then the masking tape removed to reveal the metal surface where the bonding is to take

The best RF bonds use areas of highly-conductive plated surfaces, pressed metal-to-metal



Spot-welding is as good or better than pressing metal-to-metal at fixing points, remembering to space them closer together to allow for the ones that don't work. Seam-welding (or brazing or seam-soldering) along all joints is even better, and is used where the highest RF performance is required.

An alternative to seam welding/brazing/soldering in the creation of an RF Reference is to use conductive gaskets, often called EMC gaskets, to provide low-impedance bonding all along a metal joint. Such gaskets are mostly used to create EMC shielded cabinets, and the way in which they are used to help create RF References is no different Using gaskets instead of multiple screw fixings and/or welding helps speed the assembly, and disassembly of cabinets.

### 2.5 Using gaskets effectively

gasket materials) because no one type of assembled they should be compressed to gasket is suitable for all applications. This use in any detail, except to say that when wealth of data and application assistance choice of gasket materials and styles for gaskets, and each one offers very many different styles (see Figures 8 and 9 for guide will not discuss gaskets and their (for example [27]), covering the correct required for correct mechanical design. EMC gasket manufacturers provide a an amount within their manufacturers require considerable pressure. Good recommended range - and this can particular applications, and the data some examples of just two types of There are many suppliers of such different gasket materials in many

Even gaskets that are easily squashed flat between two fingers can require very large compression forces when used in long strips, so the effective use of gaskets requires careful mechanical and fixing design to prevent metal parts from bending too much. It is not unusual to fit strips of very soft conductive gaskets to the door of an industrial cabinet, only to find that it becomes almost impossible to close, and once closed it bends like a banana opening up large gaps that defeat the purpose of the gasketting.

# 3 Wiring and cabling techniques

#### 3.1 Routing send and return paths close together

Conductively-covered hollow elastomer and foam gaskets

15

Fig 8

closest possible proximity over their whole route, as shown in Figure 10. source to the load (driver to receiver) and area enclosed by this loop is as small as provide a wire for the send current path, DC) and signals (whether data, control, analogue, inputs, outputs, etc.) have a back again. It is vital for EMC that the and a conductor for the return current path, and route them together in the possible, which means that we must current that flows in a loop from the

as good, and ribbon cables and bundles of indeed for EMC, but coaxial cables are not pairs can also be used and are very good quads are required instead, for instance four wires). Shielded (screened) twistedindividual wires can cause big problems conductors together, to make a twistedpair cable (sometimes twisted triples or for three-phase AC with either three or It is best to twist the send and return

Figures 11 and 12 show some methods for EMC performance from wire bundles and For more information on getting the best cables (unshielded or shielded), see the improving the EMC of unshielded wires. 2006 version of [28].



Fig 9

Can have the lowest closure forces of any gaskets and can also provide a degree of environmental sealing

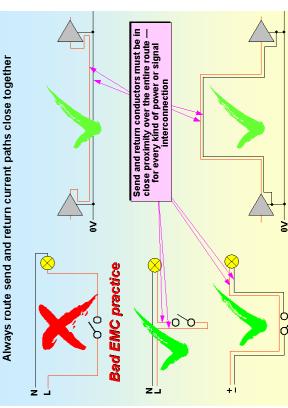
A selection of low closure force foam-cored gaskets from Chomerics

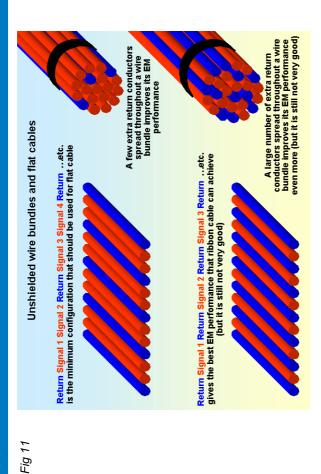




All electrical and electronic power (AC or

Fig 10





Example of connector for a flat cable that goes:

Return Signal 1 Signal 3 Signal 4 Return ...etc.

Example of connector for a flat cable that goes:

Return Signal 1 Return Signal 2 Return ...etc.

Example of connector for a wire bundle that has just a few return conductors

Example of connector for a wire bundle that has a good number of return conductors

Example of connector for five twisted-pair cables

A dedicated pair of adjacent pins for each cable

cabinets such currents are carried by solid voltages or currents they carry, so filtering excellent 'accidental antennas' for any RF conductors can cause insulation damage Where thousands of amps of current are twisted, and their separation means that may be needed to reduce their levels of RF, or else the cabinet may need to be due to the electromechanical forces on nearby electronics. Busbars can make involved, twisting the send and return the conductors - but inside industrial busbars anyway. Busbars cannot be vicinity, which can be a problem for magnetic and electric fields in their their currents create high levels of shielded.

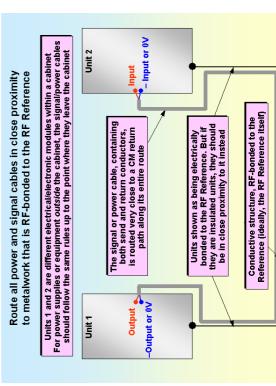
The best busbars for EMC use solid insulation (instead of air) and very close spacing between bars carrying send and return currents. In three-phase mains supplies, or three-phase motor drive cables, each of the phases is the return for the others.

## 3.2 Routing cables close to the RF-bonded metalwork

As discussed in 1.4, an RF Reference is only useful for assisting or improving the EM performance of a circuit if it is local – meaning closer than  $\lambda / 10$  at the highest frequency to be controlled (e.g. closer 30mm to control up to 100MHz) – much closer spacing means better EMC. This section discusses techniques for achieving the appropriate spacing for wire bundles and cables. Section 4 discusses the spacing and bonding of electronic units with respect to the RF Reference.

Wires and cables, and bundles of wires and cables, should <u>never</u> fly through the air. They should instead be routed along their *entire* lengths as close as possible to metalwork that has a continuous conductive path with a low RF impedance, all the way back to the RF Reference plane, as shown in Figure 13.

Fig 13



currents that leak from all wires and cables the wires and cables with what is known as lower the RF impedance and the better the image plane, so the better the EMC. If the accidental antenna effects shown in Figure 3, and further improves EMC by providing an 'image plane'. The wider the metal, the Reference, bonded to other parts of the return path for the common-mode (CM) Reference as described in section 2 -This metalwork creates a preferential (even shielded ones), reducing the above that would be ideal for EMC. metal structure is a part of the RF

simply stuff all the wires and cables inside he send and return conductors are single: wires it would be better to twist them or at the trunking and clip its lid on. But where wires and cables, and the tendency is to Industrial cabinets that use backplates generally use plastic trunking for their

east tie them together in a bundle (see trunking, so that they cannot lie too far Figure 11) before placing them in the rom each other.

50 or even 75mm above it, which does not give the best EM performance. It would be the wires and cables might lie as much as below), or else tie these cables directly to Plastic trunking helps to keep conductors is always the RF Reference) but some of reasonably close to the backplate (which critical cables (Classes 1 and 4, see 3.3 better for EMC to use 'shorter' trunking, backplate, at least for the more EMCthat keeps conductors closer to the the backplate.

the routing of wires and cables in corners Figures 14 and 15 show how to deal with and across joints in the RF Reference.

bonding fixing (add a fixing, if Wires and cables should not cross joints and seams in places like this necessary) RF Reference  $\otimes$  $(\mathcal{R})$ 

edge of the metal should be at least three should not go too close to the edge of the metal structures they are routed close to. especially important for Classes 1 and 4 Where practical their distance from the times their height above it, and this is Conductors carrying power or signals (see 3.3).

unit, while Figure 17 shows a flat cable to a PCB. Shielded cables should have their

shields bonded to the RF Reference at their ends, or as close to their ends as

Figure 16 illustrates this for a packaged

possible, and this is discussed in section 3.7.

modules or other products, they should be also be RF-bonded to the Reference (see routed very close to the RF Reference as section 4), and if they have a metal body the conductors should be routed close to length. Ideally, the PCBs, units, etc., will Where conductors connect to electronic much as is possible along their entire that until reaching their connectors or printed circuit boards (PCBs), units,

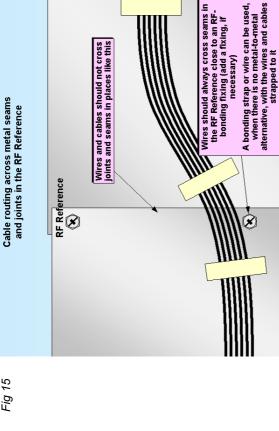
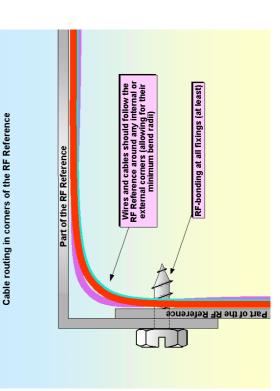
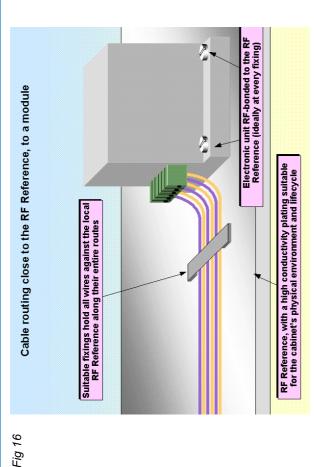
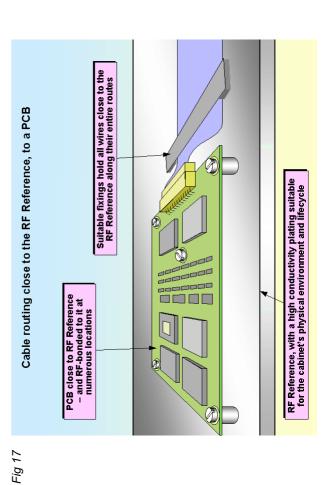


Fig 14







### 3.3 Segregating different Classes of conductors

Cables inside a cabinet should be split into at least 4 classes, based on the guidance in [18], as follows:

Class 1 is for conductors carrying very sensitive power or signals. Low-level analogue signals such as milliVolt output transducers and radio receiver antennae are in Class 1A. High-rate digital communications such as Ethernet are in Class 1B. Classes 1A and 1B should not be bundled together, although their bundles may be run adjacent to each other.

All Class 1 cables should use fully shielded cables and connectors over their entire path, with 360° shielding maintained throughout, from end-toend (see [28]). Unshielded twistedpairs are commonly used for Ethernets and similar data cables, but they are generally not as good for achieving the full data rate or EMC as shielded twisted pairs of otherwise identical specification.

Class 2 is for conductors carrying slightly sensitive power or signals, such as ordinary analogue (e.g. 4-20mA, 0-10V, and signals under 1MHz), lowrate digital communications (e.g. RS422, RS485), and digital inputs or outputs (i.e. on/off signals, not serial or parallel datacommunications; for example signals from limit switches, encoders, pushbuttons, etc.).

Class 3 is for slightly interfering power or signals, such as low voltage AC distribution (< 1kV) or DC power (e.g. 48V telecommunications power), where these do not also power noisy apparatus. Power distribution that also

feeds noisy equipment may be converted from Class 4 to Class 3 by the correct application of filtering (not a trivial exercise, see [29]). Class 3 also embraces control circuits with resistive and inductive loads, where the inductive loads are suppressed at the load (e.g. the electrical coils of relays, contactors, solenoids, actuators, valves, etc.); direct-on-line (DOL) AC motors, and so-called 'sparkless' or 'pancake' DC motors.

maintained throughout, from end-to-end DC links, and DC-DC power converters. includes all the power inputs or outputs and AC-DC power converters and their cables should use shielded cables and antennae and unsuppressed inductive equipment (e.g. plastic welders, wood associated with electrical welders; RF (to or from) variable-speed AC motor motors or sliprings; and similar 'noisy' drives; frequency converters; AC-AC apparatus. Cables to RF transmitting oads are also Class 4. All Class 4 microwave dryers and ovens); DC Class 4 also applies to the cables interfering power or signals. This Class 4 is reserved for strongly connectors with 360° shielding gluers, diathermic apparatus, (see [28]). The switch-mode power electronic circuits used in variable-speed AC motor drives; frequency converters; AC-AC and AC-DC power converters; DC-DC power converters and the like (including most types of uninterruptible power supply) produce very high levels of RF noise on their power inputs and outputs, which is why they should be assumed to be Class 4 in the absence of any EMC test data. However, their inputs and outputs can be filtered to

reduce their cables to Class 3, or even to Class 2

Fig 18

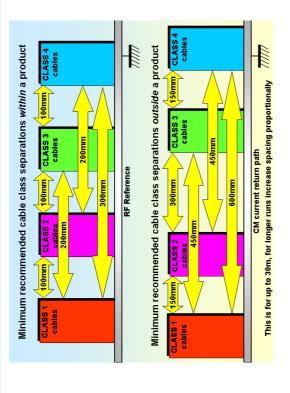
CISPR 22, EN 55022, EN/IEC 61000-6-3 with relevant conducted mains emissions For example, most chassis-mounted and should be used to be sure of complying manufacturers also make filters suitable (as appropriate) with varying degrees of east recommend which makes/models output waveform into a sinewave or DC worst of the RF noise, or to convert the nput and output filters and are claimed power converters, either to remove the manufacturers of converters should at for fitting at the output of switch-mode available from numerous suppliers for relevant emissions standards (usually modular DC power supplies contain by their suppliers to comply with the incorporated in their unit. A few filter the mains inputs of all switch-mode standards - if they are not already power converters, and responsible or EN/IEC 61000-6-4). Filters are

Most variable-speed AC motor drive manufacturers specify the use of a shielded cable 360° bonded at both ends, for their motor cables, but when fitted with a suitable 'sinusoidal output filter' their motor cables can be treated as Class 3 instead. The cost of such filters appears to discourage many industrial cabinet designers from using them, but overall there are usually significant financial and EMC benefits to be had in using them to eliminate Class 4 shielded cables and their segregated routes from the final installation.

These four classes should be physically segregated within the cabinet at all times, and as Figure 18 shows, long parallel runs should not be any closer than 100mm, if possible, as well as being run as close as

possible to the RF Reference. If cables of different classes must cross over each other, they should only do so at right angles. Greater spacings are required for parallel routes outside the cabinet, as shown by the lower part of Figure 18, but good EMC engineering techniques for systems and installations are not the subject of this guide (see [3] instead).

often causing emissions in the hundreds of power and signals that are intended to be necessary to increase the classification of indicator lamp outputs). What is often not data busses are usually the chief culprits, MHz from conductors ostensibly carrying The above classification is based on the a conductor depending on other factors. content. Harmonics of digital clocks and conversion within a unit, these I/Os can carry high levels of unrelated CM noise or example, many modern electronic appear to be relatively benign in EMC terms (e.g. audio outputs, inputs from realised is that where there is digital devices have I/O signals that would pushbuttons, thermocouple inputs, that can have a very significant RF processing or switch-mode power in the conductors, but it might be very innocuous signals. Home-made close-field probes and low-cost portable spectrum analysers, such as those shown in Figure 19, can be used as described in Parts 1 and 2 of [12], to identify such problems early in a project. They help choose industrial components that have fewer EMC problems, and/or help choose the appropriate type of shielded cables and connectors (see [28]) and/or choose appropriate filters, such as clip-on ferrite suppression chokes (see [29]) — so that cables can be bundled with others of the same Classes without causing interference.





talkies, vehicle mobiles, and RF production GSM, GPRS, Wi-Fi, Bluetooth, 3G or other incorporated into industrial systems these especially a problem for cables that leave and connectors, and/or filtering - so that or enter a cabinet, so are exposed to the choosing the appropriate types of cables exposed to the strong RF fields near the broadcasting stations, hand-held walkiebundled with others of the same classes dealt with by assessing the external EM external EM environment. This issue is sealers, microwave dryers, etc. This is equipment such as induction furnaces, environment as described in [15], then antennas of radio transmitters such as days, or where cables are exposed to cables exposed to such fields can be dielectric heaters, plastic welders or powerful RF fields from radio or TV Another problem arises with cables radio transmitting devices often without causing interference.

classes used to five six or more; increasing to the cables, and real-life experience, and so they are at best a very rough guide and in the electrical/electronic units connected cable classes, as shown in Figure 18, are routing closer to the RF Reference are all ways of improving EM performance more about the types of cables and the circuits cannot be expected to be adequate in all the spacing between parallel routes, and cases. Increasing the number of cable based upon a number of assumptions The recommended spacings between than would be achieved by the above

operating with their intended power/signals spectrum analysers, as discussed above, guesswork from this whole issue, and is generally recommended no matter what Actually testing cables (when they are and loads) with close-field probes and is a very big help in removing the

EM specifications suppliers claim their products meet.

### 3.4 Reducing Class spacings

increased beyond the recommendations in spacings between parallel routed cables of Where wires and cables cannot be routed different classes should be significantly close enough to the RF Reference, the Figure 18.

Where practical considerations prevent the improved EM performance will reduce the between classes, using conductors with achievement of the ideal spacings spacings required. This technique involves...

- Adding more return conductors in wire bundles, see Figures 11, 12 and the 2006 version of [28]
- Replacing straight send/return wires in bundles with twisted pairs, triples or quads as appropriate
- cables by shielded types using correct shield terminations at both ends, see Replacing unshielded (unscreened) [28]
- Replacing shielded (screened) cables specifications and/or higher-quality terminations at both ends, see [28]. by types with a higher shielding

of the electrical/electronic units used in the connectors provided by the manufacturers equires 360° bonds - not pigtails - see together. The limiting factor is usually the plastic-bodied connectors make it difficult cabinet. For example, screw-terminal or to terminate cable shields correctly (this performance of conductors by so much, that all the classes can be bundled It is possible to improve the EM

bodies are provided – if the manufacturer Even where D-type connectors with metal of the unit has not correctly bonded the Dwasted. It makes good sense to consider the EM performance available from  $360^\circ$ ype to his units internal RF Reference, terminating the cable shield will be such aspects of equipment before purchasing them.

between classes by improving the filtering impractical to open up purchased units to applied to the electrical/electronic units at one or both ends of the conductors. It is cables at the point where they enter/exit more usual to add external filters to the performance and reduce the spacings improve their internal filtering, so it is It is also possible to improve the EM the units.

cables are ferrite chokes, a wide range of manufacturers to suit round or flat cables, plastic clips that make it easy to clip them many of them available in split form with The easiest types of filters to add to which are available from many

onto existing cables, as shown in Figure

helps to choose the appropriate type. If the can be found with a close-field probe and probe shown in Figure 5 of Part 1 of [12]. different materials, to suppress different problem frequencies are unknown, they Figure 19, or with the CM cable-current Cable-mounted ferrites are available in ranges of frequencies, so it obviously spectrum analyser such as shown in

It is also possible to connect filters such as contain capacitors, such as those in Figure 21. Some of these issues are discussed in surrounding the effective use of filters that change a cable from one Class to a lower. those in Figure 20 is quite straightforward, cables, to improve their EM performance, reduce cable Class spacings, or even to sections 4.7 and 5.2, but for more detail those shown in Figure 21 in series with Whereas adding ferrite chokes such as here are a number of detailed issues please read [29].





Some examples of cable ferrites



Sometimes filtering and shielding can be Noti effectively applied together. For instance, Figure a shielded cable can only achieve a this poor shield termination (e.g. a pigtail, see accosection 3.7.6), a ferrite clamped over the sma cable at that end can improve matters.

### 3.5 Segregating cables in industrial cabinets that use backplates

The various electronic, electrical, pneumatic, hydraulic, etc., units should be located to keep sensitive units such as transducer amplifiers or programmable logic controllers (PLCs) well away from electrically noisy units such as relays and contactors or variable-speed AC motor drives ('inverters'), to help prevent them from interfering with each other. They should also be located so as to aid the segregation of the cable classes. Figure 22 is a sketch of a real-life industrial control panel, using an ordinary unshielded cabinet, which was designed according to this guide and successfully tested for EMC compliance.

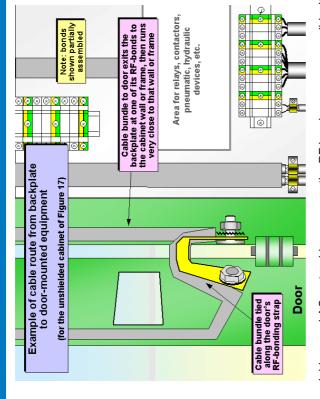
Notice that the Class 1 and 2 cables in Figure 22 are run in the same trunking – this was a compromise that was felt to be acceptable because this panel was quite small, and also because there were very few Class 1 signals and they were not very sensitive. There is nothing wrong with compromise, it is the life-blood of engineering after all, but it is very important that people competent in the disciplines involved (EMC in this case) determine such compromises, case-by-

As in Figure 22, it is best to try to have no internal Class 4 cables at all, or at least minimise their internal lengths as much as possible. This means fitting units such as inverter motor drives near to the wall of the cabinet so that their motor drive cables (Class 4) can exit directly, and filtering any Class 4 incoming cables (e.g. very noisy mains supplies) as close as possible to their point of entry to make them Class 3 or 2. Figure 23 shows more detail of the motor drive area of the cabinet from Figure 22. The manufacturer's EMC instructions

Zinc-plated backplate used as the RF Reference Door isolator the cabinet Mains filter AC motor drive and 24VDC psu its filters Example of backplate layout in an unshielded industrial cabinet Class 4 Area for relays, contactors, pneumatic, hydraulic devices, etc. (not generally recommended) strapped to one of its RF bonds to the cabinet Trunking for user's Class 1 and 2 cables units exit the backplate combining Class 1 and 2 Trunking for Class 3 Fig 22

Zinc-plated backplate used as an RF Reference dy RF-bonded to backplate at all fixings Mains cable Base of cabinet Details of the assembly in the motor drive area Motor cable – Class 4 minimal length inside cabinet, not routed near any cables of other classes Bookshelf style mains filter for the motor drive Supplier-specified ferrite toroid with specified number of turns of the previous Figure speed AC motor drive 0 Plastic cable gland 360° shield termination to backplate using a saddleclamp Drive's metal body RF-bonded to backplate at all fixings Fig 23

Fig 24



for this variable-speed AC motor drive required the use of a specified ferrite toroid with a specified number of turns on it, plus the use of shielded motor cable with the shield terminated 360° (see [28]) to the motor drive's metal chassis, and also at the motors metal terminal box (a typical requirement for inverter drives that do not have 'sinusoidal output' filters fitted to their motor cables very close to the

Figure 24 shows the remainder of the route of the bundle of cables in the top left-hand-corner of Figure 22, which are leaving the backplate area to connect to electronic units mounted on the door of this ordinary unshielded industrial cabinet The cables are run close to the local RF Reference over their whole length, which means exiting the backplate at one of the points where it is RF-bonded to the cabinet wall or frame, actually tied down

the RF bond as near as possible. It is then routed along the wall or frame until it crosses to the door strapped to a short braid that RF-bonds the door to the cabinet wall. Hinges cannot be relied upon to electrically bond doors to cabinets, as they usually contain grease or plastic inserts. In a well-shielded cabinet the door will be bonded all around by a conductive gasket, so it does not matter where the cables cross the hinge area.

#### 3.6 Segregating cables in rackmounted equipment

Where the design of the rack-mounted units can be controlled, for example when they are made by the same company, they should segregate their rear-panel connectors to facilitate the segregation of cable classes within the cabinet, as shown in outline in Figure 25.

Notice also that Figure 25 shows how the racked units should be organised to place

in such a way that it follows the route of

Class 4 Class 1 Class 2 Rear view Example of segregation in a 19" rack cabinet More sensitive More noisy Variable speed AC motor drives (PWM) (very noisy) Transducer amplifiers and A/Ds (very sensitive) (both noisy and sensitive) Relays and contactors (very noisy) Telecomm's (sensitive) Switch-mode DC power supplies (noisy) Side view Computers Fig 25

the ones with the highest levels of RF noise (relays, contactors, switch-mode power converters such as variable-speed AC motor drives and the like, etc.) far away from the units that are the most sensitive (computers, PLCs, displays, transducer amplifiers, telecommunications, etc.).

Where the rack-mounted units are purchased from a variety of suppliers there will probably be no consistency at all between their rear-panel connector layouts, and often no segregation between different cable classes either. In such cases it is important to determine which cables belong to which Class, and segregate them as close as possible to the rack units so that they can be bundled with their own Class for routing within the

Creating an RF Reference for conductors to be routed against is not as easy when

using a rack cabinet, as it is for a backplatetype industrial cabinet. Generally, it requires
providing horizontal shelves for the rack unit
to stand upon (as well as the units being
bonded to the frame via their rack-mount
'ears'). These shelves should extend well
beyond the rear panels of the units, and be
RF-bonded to vertical metal sheets at the
sides of the cabinet. Cables entering/exiting
the rear panels of the racked units can then
be routed close to their units shelves, where
they will be sorted out into their Class
bundles, then those bundles routed to the
side sheets to run vertically between the
shelves.

Of course, all the shelves and vertical sheets should be RF-bonded to each other and to the frame and other metal parts of the cabinet, as shown in Figures 4 – 7, to help create a good RF Reference as described in section 2, and the cables or cable bundles should be routed as shown in Figures 14 and 15.

32

Fig 26

Common Transducer Transducer amplifiers drivers Digital I/O Mains EMI filter amplifiers Analogue signals

The sensitive circuits are as far from the noisy circuits as possible, and all the different types of cables run in separate bundles kept close to chassis metalwork

placement of electronic units and routing of where they need functions not available as a standard product, or where they hope to reduce cost. Figure 26 shows an example make their own rack chassis units, usually manner to the Class structure discussed cables routed close to the metal chassis Some industrial cabinet manufacturers shows the sensitive units kept far away and segregated by function in a similar interconnecting cables within a unit. It from the ones that create the most RF noise (the digital processing and the switch-mode power supply), and the providing general guidance for the earlier.

practice

This guide is not intended for the manufacturers of electrical/electronic units – it is meant for industrial cabinet manufacturers who purchase such units from third-party suppliers. Companies that wish to know more about the good EMC practices in the design and assembly of electrical/electronic units are recommended to read and apply all of the

series that includes [28] [29] [30] and [31], and they will also find [12] useful.

# 3.7 Bonding cable shields (screens) to the RF Reference 3.7.1 Bonding cable shields at both ends is good EMC engineering

Cable shields should generally be bonded to their local RF References at *both* ends. This is because a shielded cable that is only bonded at one end can only provide good shielding performance up to a frequency at which its length becomes a significant fraction of the wavelength. The higher the shielding effectiveness required for the cable, the smaller the fraction of a wavelength permitted. To put some rough guidelines to this: for shielding of around 20dB at a given frequency with the shield only bonded at one end — the cable length should be less than one-twentieth of the wavelength at that frequency.

For example, at 400MHz (close to a typical transmitting frequency for walkie-talkies used in industrial premises) one wavelength in air is 0.75m, and one-twentieth of that is 37.5mm. This means that shielded cables which have their shields bonded at one end only, should be no longer than 37.5mm to maintain a shielding effectiveness of at least 20dB at up to 400MHz (to help prevent close proximity of walkie-talkies resulting in interference). If cables need to be longer than this (and most will be) they will need to have their shields terminated at both

better braid-shielded cables generally have Of course, nothing is as simple as this, and better shielding performance than wrapped 360° fittings in connectors and glands. The frequencies. The very best flexible shielded cables are the (expensive) 'superscreened' braid or braid-and-foil may be used to give most types of flexible shielded cables will good optical braid coverage, and doublebe losing their shielding effectiveness by foil types, and are easier to terminate in 400MHz. Braided cables generally give shielding braids as well as at least one cable types, which employ multiple even better performance at higher layer of 'MuMetal' tape. Another problem with bonding a cable's shield at only one end, is that it then cannot provide any shielding at all from some orientations of magnetic fields. Shielding from these requires a current to flow in the shield from one end to the other, which can't happen if the shield is only bonded to the Reference at one end.

In some more extreme industrial environments there can be significant potential differences between the local RF References of items of equipment located in different areas of the site. These

the AC power supply, typically either 50 or This is a problem for the installation rather are described in more detail in [3] and [18] 60Hz. Bonding both ends of the shields of cause high levels of shield current to flow. However, cabinets should be designed to and is dealt with by the use of techniques fixings suitable for the connections of the engineering practices, so should provide cables that interconnect these items can ducts, armour, trays, etc.) - see [3] and allow their installation to use good EMC earthing conductor (PEC) both of which voltages are usually at the frequency of than the internal assembly of a product, network (MESH-CBN) and the parallel such as the meshed common bonding external PECs (which could be wires,

With properly designed electronics, the only significant consequences of shield currents is heating of the cables — so-called 'hum loop' or 'ground loop' noise are a consequence of poor electronics design, which allows cable shield noise currents to flow directly into electronic circuits (usually by connecting the cable shield directly to the circuit's 0V). This issue is outside the scope of this article, but is dealt with in more detail in section 2.6.8 of the 2006 version of [28].

Of course, industrial cabinet manufacturers usually rely on third-party suppliers for their electronic units, which is why it is best for them to carefully check the EMC installation instructions for any unit, module or product they are considering, to find out if they require any cable shields to be bonded at only one end (there are other things to discover too, see [14]). This is typically an indication of poor design for EMC, although in some equipment intended for use in explosive atmospheres, it might sometimes be necessary for safety reasons.

### 3.7.2 Capacitive and hybrid shield bonding

If, for some reason, bonding the shield at both ends is impractical, it may prove acceptable to connect a short-leaded ceramic capacitor from one end of the of the cable's shield to its local RF Reference (instead of directly bonding it 360° metal-to-metal). This method is sometimes called hybrid shield bonding, because one end has a direct bond to its local RF Reference, while the other has a capacitive bond. (If both ends use capacitors in series with their shield terminations this is known as capacitive shield bonding.)

The frequencies and frequency ranges over which capacitive and hybrid bonding are effective depend upon the types of capacitors used and their values. The lengths of the capacitors' leads and any wires or conductors attached to them should *always* be minimised.

and transients of at least 500V, and maybe voltages they have to withstand, and in the (LEMP) and also by induced coupling from caused by lightning electromagnetic pulse sources of surge or transient overvoltages in some types of installation, such as large banks (e.g. for power factor correction), or case of cables external to the cabinet and be rated to withstand overvoltage surges longer than about 10 metres they should electromechanical contactors, capacitor routed nearby. There may also be other carrying lightning surges that might be The capacitors should be rated for the installation. These surges are typically mains cables or lightning conductors as much as 10kV, depending on the AC or DC motors controlled by superconducting magnets.

Where safety is a concern, the capacitors used may need to be safety-rated (and it is

recommended that they are purchased as safety-approved and their approval certificates checked with their issuing bodies to make sure they are not forgeries.)

Fig 27

Unfortunately, without using special (and expensive) annular capacitors it is difficult to make capacitive shield bonding work well at the higher frequencies being used by modern electronic equipment, or work well over a wide range of frequencies. So hybrid shield bonding is a technique best kept in reserve to deal with special situations, such as where 360° bonding at both ends is not possible for some reason — and the frequencies for which the cable needs to have good shielding are grouped into a fairly narrow range.

Where a cabinet provides for cable shield bonding at both ends, on-site replacement of direct bonds by capacitors is not too difficult, and removing the bonds altogether (should it prove necessary) is very easy. However, if the cabinet was designed to have its cable shields bonded at only one end only – attempting to fit capacitors or 360° bonds at the other ends to solve EMC problems on-site or during compliance testing can be very difficult and time-consuming.

# 3.7.3 It is best not to use a cable's shield to carry the return current

Wherever possible, never use the shield of a cable as the return conductor for the electronic signals (digital, control or analogue) or electrical power carried by its conductors — always use a twisted pair, or twisted triple, or twist whatever number of conductors it takes to fully embrace all the send and return current paths for a given power or signal connection.

Coaxial cables are often thought to be the best for controlling RF, because of their

Example of 360° termination of cable shield in a D-Type connector backshell bends to mating half all around (360°)

Metal for metallised bends to mating half all around (360°)

Some other 360° bonding methods and types of 360° shielded connectors can be equally acceptable, or better

widespread use in RF and EMC test equipment — but in such applications the cables are always used as matched transmission lines, rarely the case in the industrial world. When not used as matched transmission lines in a controlled-characteristic-impedance interconnection system, coaxial cables are not as good for EMC as shielded twisted pairs, because they carry their return current in their shield, instead of in a dedicated conductor. [28] goes into this issue in more detail.

# 3.7.4 Techniques for bonding cable shields to the RF Reference

External cables entering a cabinet should have their shields RF-bonded to the cabinet's local RF Reference as soon as they cross its boundary. This applies even though they may also be bonded internally to the same Reference at another place, for instance at an electronic unit (see section 4).

An obvious way to bond a shield to the RF Reference is with a shield-bonding

connector, such as the types shown in Figure 27 (a D-type) and Figure 30 (a bayonet-locking circular connector), with the chassis-mounted mating connectors themselves bonded metal-to-metal to the RF Reference at the edge where the cables enter or exit the cabinet.

clip or screw head or solder it to the body of shield bonded using a saddleclamp, which available that provide a proper 360° shield the connector, like the connector shown in inferior to the saddleclamp method shown wrapped shield, and trap it under a spring Figure 28. These types are all noticeably The D-type in Figure 27 shows the cable in Figure 27. D-type backshells are also from the braid or the drain wire of a foiltermination but nevertheless is often an require the assembler to make a pigtail acceptable alternative. Some D-types does not really provide a 360° shield ermination, and these are generally preferred. Many shielded D-type connector backshells do not provide a strain relief clamp for the cable jacket. In such situations, where the

Example of a crimp ferrule system that provides 360° shield bonding, strain relief and easy assembly without any cable clamps

Fig 29

(from Intermas GmbH, www.intermas-gmbh.de)



the cable and flance adapte The ferrule is crimped ove



this makes the EMC performance depend best EMC performance is required as well required, it is usual to fold the shield back over the outer jacket and clamp both the bonding of the undisturbed shield plus a strain relief clamp for the cable's overall shield and jacket at the same time. But type of connector) should provide 360° greatly on workmanship, so where the as strain relief, a D-Type (or any other very best EMC performance is not acket.

connector is finally assembled, as shown shielding backshell systems for D-Type bonding and strain relief functions in a crimp accessory that attaches a metal flange to the cable - the flange being Some connector manufacturers offer connectors that combine both shieldclamped by the backshell when the and other multiway rectangular in Figure 29.

currents. Figure 30 shows a cross-section available in round and rectangular styles that will take very large number of pins, and carry signals or power up to high Shielded industrial connectors are

cable shield and connector body, and also provides a strain relief and environmental very high quality of 360° bond between of a circular connector that achieves a seal.

termination exist, but only those that make a 360° electrical bond between the cable's work well for EMC. Any connector bonding extending it with wires (see the section on Many other types of connector and shield shielding performance of the cable and/or shield, the connector's backshell, and the technique that involves disturbing the lay mounting panel of the mating connector) of the foil or braid of the cable shield, or mating connector's backshell (or the pigtails' below) will compromise the the connector.

around an undisturbed cable shield (e.g. a Glands that bond with uniform pressure all performance, and an example of this type an RF Reference, as shown in Figure 31. the RF Reference as a cable enters/exits instead of connectors; to bond shields to 360° bonding 'iris' spring or 'knitmesh' Shielded cable glands can be used gasket) generally give the best RF

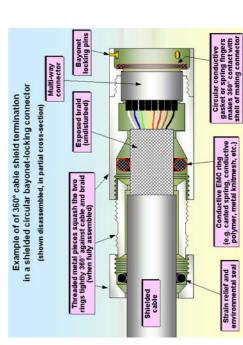


Fig 28



is shown in the top left of Figure 31. This type of gland uses the same design principles as the circular connector sketched in Figure 30, and is generally the best type to use for good EMC performance.

The type shown at the bottom-right of Figure 31 relies upon the assembler cutting the braid and spreading it over a plastic part before assembling it to the metal part that bonds to the RF Reference. Although this type of gland has a lower cost, the extra work required to assemble it costs more, and there is also the possibility that the assembler will not spread the cut braid evenly, or make other mistakes that degrade EMC performance.

Some manufacturers of cabinets or terminals sell their own cable shield bonding accessories. As long as they provide 360° (full circle) bonding *directly* between the cable shields and the *surface* of the local RF Reference they will give good performance. But beware – some of these attach the cables' shields to metal bars that have appreciable inductance, and these then usually connect to the local RF Reference by a wire or braid strap –

adding even more inductance.

Mass shield termination as shown in the bottom-right of Figure 31 is a low-cost technique relying on clamping a number of exposed shields between conductive gaskets. It is quite easy to design similar shield bonding methods into, say, the base of cabinet, using simple metalwork and standard gasket types, as shown in Figure 32. This type of design easily outperforms many of the proprietary shield-bonding accessories offered by cabinet or terminal manufacturers.

Another method of mass-terminating cable shields is shown in Figure 33. Like Figure 32, this method can be easily adapted to suit a variety of situations.

Figure 34 shows two examples of terminating cable shields as they enter or exit the RF Reference plane in an industrial cabinet that uses a backplate. The saddleclamp method can also use Pclips, which do not provide as good a shield termination as a saddleclamp, which in turn is not as good as a proper 360° shield bond. But P-clips may be perfectly acceptable where the EMC performance is not required to be the highest. Saddleclamps and P-clips used to

(many other good methods can be devised)

External cables

entering/leaving the area of the Reference
(Strain relief and environmental sealing not shown)

environmental sealing

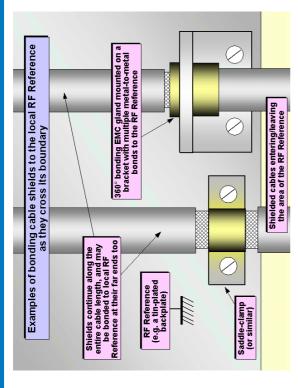
RF Reference
(Strain relief and environmental sealing not shown)

environmental sealing

RF Reference
(Strain relief and environmental sealing sealing suitable for the cabinet's physical environment and lifecycle

(e.g. backplate, cabinet's physical environment and lifecycle suitable for the cabinet's physical environment and lifecycle soft conductive gasket, one above and one below the cables, create 360° bonds between cable shields and chassis when the clamp is tightened up

Cable shields exposed and clamped to the castellated fingers' with metal cable ties, band clamps, etc. (e.g. backplate, cabinet wall or floor, etc.) with a highly conductive plating suitable for the physical environment and lifecycle of the cabinet Easily bonding multiple cable shields to an RF Reference (b) A castellation RF Reference (many other good methods can be devised) (strain relief and environmental sealing not shown) entering/leaving an area controlled by an RF Reference External cables plating suitable for the physical environment and Reference along its length Castellated metal bracke lifecycle of the cabinet, with multiple metal-tometal bonds to the RF with highly conductive Fig 33



have to be obtained from plumbing, pneumatic or hydraulic component suppliers, maybe because the parts were too low-cost to be of interest to other manufacturers. However, there are now some EMC component suppliers who offer saddleclamps and P-clips for cable shield bonding.

Where shielded cables don't employ shielded connectors at their ends or at junctions, and use unshielded connectors such as DIN rail terminals instead, their unshielded conductors degrade their EMC performance. Figure 35 shows how to use metal saddle-clamps (or P-clips) to bond the cable shields to RF Reference as close as possible to the unshielded terminals. The minimum length of conductors should be exposed, all the same length, as short as possible and routed as close as possible to the RF Reference.

Figure 35 shows DIN rail mounted terminals, but they could instead be screw or solder terminals or unshielded

connectors on an electronics unit. Where the unshielded connector is mounted on an electronic unit, the best place to bond the shield is to the metal (or metallised) body of the electronics unit itself, close to the connector, but if this is not possible the nearest local RF Reference should be used instead – generally the metal surface the electronic unit is mounted on.

A number of practical alternatives to saddle-clamps exist, and the inventive designer will have no trouble in creating new constructions to ease assembly of his cabinets. The EMC performance of the unshielded connectors and exposed cable conductors will not be very good, but this design technique aims to make it as good as possible without changing to a shielded connector.

The EM performance of a shield bonded with a P-clip will generally not be as good as one bonded to its RF Reference by a saddleclamp, but because the EM performance of the unshielded connectors

Example of cable shield bonding at unshielded connectors/terminals

Example of use with wiring to DIN rail terminals with a high conductivity plating suitable for the physical environment and lifecycle of the cabinet with a high conductivity plating suitable for the physical environment and lifecycle of the cabinet with a high conductors as short as possible (<30mm)

Exposed conductors as short

Exposed cable shield, preference as possible (<30mm)

Metal saddle-clamp bonds shield to Reference as close as possible to the unshielded terminals

P-clips are often an acceptable alternative to saddleclamps in these applications

is so poor, using P-clips might not make it very much worse. Figure 36 shows an example of an industrial panel using P-clips to bond the shields.

Where shielded cables are routed to unshielded terminals or connectors that are not very close to the RF Reference, the height of the bracket in Figure 33 can be increased to 'extend' the RF Reference closer to the terminals and provide a means for bonding the shields nearby. Although the metal bracket adds inductance and so has a deleterious effect at higher frequencies, it is orders of magnitude better than pigtailing the shields (see below).

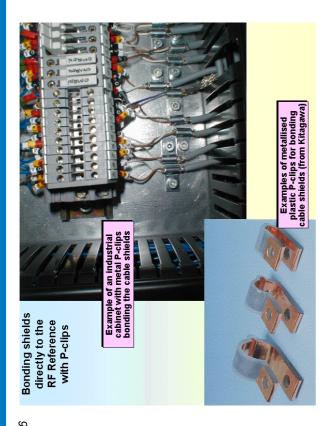
Similarly, a tall bracket could be used to support a conductive gasket clamp such as that illustrated in Figure 32, or a P-clip or saddleclamp as shown in Figures 34 – 36, close to the terminals or connectors. A tall thin metal bracket is not very much better than a pigtail (see below) at

terminating a shield — such brackets should be at least three times as wide as they are tall, and have multiple metal-tometal bonds to the RF Reference all along their length, spaced no further apart than 100mm.

If it is not practical to make a good RF bond at the end of a shielded cable using the methods described above (or similar techniques), make a good RF bond to the RF Reference as close as possible to the end of the cable, then continue the shield after this bond right up to the end of the cable – including the shielded connector backshell where one can be fitted.

### 3.7.5 Some additional shield bonding techniques

All cable shield bonding methods should make a tight fit all around the periphery of their cable's shield (but without crushing the cable), and this tight fit must not become loose with age, wear and tear. It is always best not to disturb the lay of a



cables' shield when 360° bonding to it, but where lower shielding performance is acceptable a longer length of braid shield can be 'scrunched up' to make a tight fit in a slightly loose saddle-clamp or connector backshell shield clamp.

With foil shielded cables it is important to make sure that the metal surface of the foil makes a 360° contact with the connector backshell or other shield bonding method. One side of the foil is non-conductive plastic, and of course is not suitable for shield bonding. Where it is the internal surface of the foil that is conductive, the foil will need to be folded back, and with a spiral-wrapped foil cable this is difficult to do neatly and ensure a 360° bond. It is also important for any drain wires in the

drain wire over the exposed metallised foil surface a few times to make a more reliable clamp.

It has been common practice for many years to use the drain wire as the sole means of bonding foil-shielded cables, but this creates a 'pigtail' (see below) and ruins the EM performance of the cable. Because of the difficulties associated with making a 360° bond to metallised-foil shield materials, and the resulting susceptibility to variations in workmanship, braid rather than foil-shielded cables are generally preferred.

## 3.7.6 Pigtails – making the best of a very poor EMC technique

It has been common practice for decades to bond cable shields using short lengths of twisted braid, or the drain wires in foilshielded cables, or by soldering a wire to

foil-shielded cable to be bonded along with

shielded cable is a little loose in a shield

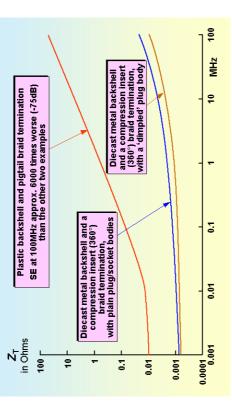
the metallised foil surface. Where a foil

clamp, it might be possible to wrap the

# Effect of pigtail on the $\mathbf{Z}_{T}$ of a 25-way subminiature D-type connector

Fig 37

From slide 27 of Lothar O (Bud) Hoeft, "Analysis of Electromagnetic Shielding of Cables and Connectors", 2002 IEEE International Symposium on EMC, Minneapolis, www.emcinfo.selfeeelprotokoll/34/EMag\_Shielding\_of\_Cables\_and\_Connectors



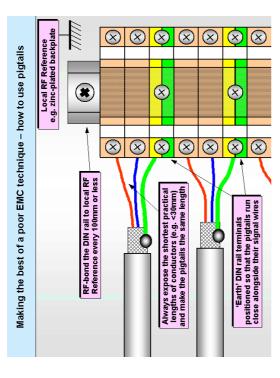
either of these to reach a distant shield bonding point. These days, and for the future, this is a terribly bad practice that effectively ruins the shielding performance of the cable. The author has measured emissions from industrial cabinets that failed the radiated tests around 70MHz because a single cable from the volt-free contacts of a PLC had a 25mm long pigtail to the RF Reference plane (the cabinet's backplate in that case). Replacing that very short pigtail with a metal saddleclamp that pressed the shield against the backplate reduced the emissions around 70MHz by over 20dB and the test was passed.

Figure 37 shows the effect of a pigtail on the surface transfer impedance  $(Z_T)$  of a 25-way subminiature D-type connector.  $Z_T$  is a measure of how well a cable or connector will function as a shield — lower  $Z_T$  at a given frequency means higher

shielding at that frequency. A  $Z_T$  of around 10 milliohms is generally adequate for average levels of shielding, but high levels of shielding require 1 milliohm or less.

Figure 37 shows that the shielding effectiveness (SE) of a subminiature D-Type using a pigtail for its cable shield bond is average at frequencies up to about 20kHz, but above that frequency progressively reduces until by 1MHz the SE is unacceptably bad. Comparing this with the proper 360° shield bonding shows that at 100MHz the 360° shield termination is 75dB better than the pigtail.

It has been a common practice among the people who wire industrial cabinets to strip about 300mm of shield from the conductors at the ends of shielded wires and solder a long length of green/yellow insulated wire to the braid or drain wire. The (now unshielded) conductors are connected to the DIN rail or other terminal,



and the green/yellow wire taken to an earth' terminal that might be up to 1.5 metres away (a substantial copper bonding bar, usually called the 'main earthing bar', is a common choice). All the spare conductors are hidden in the plastic trunking, so that the conductors that exit the trunking appear short neat and tidy. This practice should no longer be permitted under any circumstances, for the reasons described below.

The pigtail used in the tests summarised in Figure 37 was about 30mm long – and that was long enough to completely ruin the cable's  $Z_T$  (and hence its SE) above 1MHz. Longer pigtails, even if they are green/yellow insulated or even braid straps, will have even worse SE. Also, the bundling of all of the excess lengths of unshielded conductors in the plastic trunking helps ensure lots of crosstalk between the signals on those wires and other cables – quite possibly what the cable shielding was supposed to be

preventing in the first place.

sensitive transducer signals such as those the like. Also, variable-speed motor drives required for frequencies below 1MHz. And 50/60Hz electric and magnetic fields from rated at 1kW or more create high levels of and other switch-mode power converters electric and magnetic fields below 1MHz, where unshielded terminals such as DIN average level of SE up to about 100kHz, so in some cases shielding may only be from thermocouples, strain gauges and achieve good SE at frequencies much for instance to reduce the coupling of mains power cables and devices into rails are used, it may prove difficult to Sometimes all that is needed is an above 1MHz in any case. So we need a method of using pigtails as effectively as possible, and Figure 38, using the example of DIN-rail terminals, shows this. A similar arrangement may be used at the unshielded terminals of electronic units. To get the best EM performance from a pigtail, the exposed conductors and the pigtail from a cable

Always expose the shortest practical lengths of conductors (e.g. <30mm), and make the pigtails the same length Local RF Reference, e.g. zinc-plated backplate positioned so that the pigtails run close alongside their signal wires 'Earth' DIN rail terminals (still has poor EMC at >1MHz, but better than using a single pigtail) A better pigtail shield termination method Ó Q Ó Ó Ç Bond the DIN rail to the local RF Reference every 100mm or less X (X)  $\otimes$  $\otimes$  $\otimes$  $\otimes$  $\otimes$  $\otimes$  $\otimes$  $\otimes$ (x)(x)(x)(x)(x)(x)(x)(x)

should be as short as is possible, consistent with the practical needs of assembly (say, around 30 mm), and where possible they should be kept close together by interleaving the shield bonding terminals with the signal terminals as shown in Figure 38. But remember that pigtailed shields are never going to be much use for EMC above

When using DIN rail terminals to connect pigtails to the local RF Reference, the metal DIN rail itself should be bonded metal-to-metal directly to the Reference at both ends, and at other positions along its length, preferably every 100mm or less. Placing shield-bonding terminals (usually coloured green/yellow to indicate they are bonded to the DIN rail and so are at 'earth' potential) either side of the signal/power terminals also helps provide a little shielding for them, although this cannot be expected to have any significant effect above about 10MHz. On no account should the green/yellow

terminals used for bonding cable shields ever be grouped together at one end of a DIN rail, for 'neatness'.

The RF performance of pigtails can be usefully improved by using two pigtails for each cable. They should be soldered to either side of the cable, and connect to terminals either side of those used by the cable's conductors, as shown by Figure 39.

# 4 Bonding circuits and units to the RF Reference

45

Fig 40

Any insulating surface
finishes (e.g. paint, anodising) removed from the crimp tag's contact area incoming protective finish protective finish protective finish incoming protective conductor finish incoming point, with high conductivity plating suitable for the cabinet's protective conductivity plating suitable for the cabinet's protective conductivity plating suitable for the cabinet's protective conductivity plating suitable for the cabinet's physical environment and lifecycle

As discussed in section 2, an RF Reference is only useful for assisting or improving the EM performance of a circuit if it is local — meaning closer than  $\lambda 10$  at the highest frequency to be controlled (e.g. closer than 30mm, to control up to 100MHz) — much closer spacing means better EMC. Section 3 described how best to route and bond cables with respect to the RF Reference; this section discusses techniques for bonding electrical/electronic circuits, units, modules, products, etc., to the Reference.

This section assumes the use of plain unshielded low-cost metal cabinets, and the techniques described are intended to get the best EMC performance from them without adding much (if anything) to cost. Section 5 discusses the good EMC engineering practices associated with the use of shielded cabinets.

### 4.1 Protective bonding (safety) conductors

Figure 40 shows the connection of the incoming protective conductor (often called the protective or safety earth; the green or green/yellow conductor in the mains supply cable) to the protective earthing (PE) point of a cabinet. Although this bond is primarily a safety concern, it helps to achieve the best EMC performance from the cabinet if the amount of protective conductor exposed within the cabinet is 150mm or less.

Bonding it to the *outside* of the cabinet would be the best for EMC, but for safety reasons it needs to be located close to the mains terminals. Its bonding terminal is preferably welded to the cabinet side or rear, although it could be screwed. For safety reasons the best type of welded stud is one that penetrates the cabinet from the other side, so that if the weld fails it is still retained in place and doesn't just pull free.

Shortest widest bonding the study of the protective bonding in an unshielded cabinet

The raine partially at every backplate

Shortest widest bonding the study of the protective bonding case minimate the linged edge as the RF Reference shown in this walls and dons, located so as to minimate the lengths of the protective bonding wires or straps (assuming wires or straps (assuming wires or straps (assuming wires) at sufficient CSA)

Door

The notation and and only one 'earth' bond per terminal and only one 'earth' bond per terminal at each point and and only one 'earth' bond per terminal and only o

for any industrial cabinet, so that if a panel widely ignored, for example with cabinets terminal. This requirement appears to be bonding wire per terminal is good advice bonding wire disconnected, this does not For industrial motor control cabinets, the safety standard EN 60204-1 requires no more green/yellow wires connected into more than one protective conductor per 'starred' to a single stud, or with two or regulations. A single 'earth' protective making many industrial motor control being wired using several ring tags individual DIN rail 'earth' terminals, cabinets non-compliant with safety (say) is removed and its protective remove the protective bonding for

So to bond the backplate to the protective conductor I recommend a separate welded or screwed stud terminal near to the incoming 'safety earth' terminal (plus a sufficient cross-sectional area of metal between the two, see section 4.6), as shown in Figure 22.

anything else.

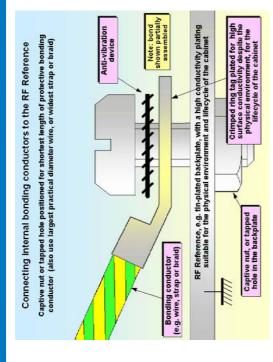
Many control panel builders instead use a

solid metal terminal block (usually called the 'main earthing bar') bonded reliably to the cabinet wall as their 'safety earth' star point, as shown in Figure 41. When using such bars, a stud that bonds the bar to the cabinet's metal wall should be located immediately adjacent to the place where the incoming protective conductor is connected.

It is always best to seam-weld all the parts of a cabinet's structure together, or else spot-weld them at multiple points along their joins, or fix them together with multiple screws or rivets that provide metal-to-metal bonding as discussed in section 2 — to help create the best possible RF Reference for the cabinet. But where it is necessary to bond them using wires, straps or braids, Figure 41 shows the basic principles for a cabinet in which safety and RF-bonding can be safely combined (see section 4.6).

Figures 22 and 41 are examples of protective bonding in typical industrial cabinets fitted with a backplate, and

Fig 42



or EN/IEC 60204-1, making sure to use the with the type of mains supply and incoming nandle the earth-fault currents associated standard (typically either EN/IEC 61010-1 temperature into account. Safety is more current edition), taking the material (e.g. (CSA) of the cabinet wall is sufficient to important than EMC, so must never be assume that the cross-sectional-area requirements of the relevant safety mild steel) and maximum cabinet compromised for EMC reasons. mains cables, according to the

practicable conductors, e.g. metal straps or braids. In general, the shorter the length of the protective bonding wire, strap or braid, the higher the frequency at which a metal Given that the above CSA requirement is cabinet provides some shielding benefits. associated with the cabinet structure that requires 'safety earthing') should make their protective bonding to their nearest cabinet walls using their own studs or terminals with the shortest and widest removable panels (and anything else met, Figure 41 shows that doors,

spaced 150mm or less apart, as shown in the part concerned - spreading them out as uniformly as practical along the length, protective bonding wire, strap or braid to achieved by having more than one short height or width concerned, preferably Also in general, better EMC will be Figures 4 and 5. Figure 42 shows the details of connecting Reference (the backplate in this example) a protective bonding conductor to the RF and should be compared with Figures 6 and 7.

matter how short they are, and a shielded cabinet dimension exceeds one-twentieth cabinet using conductive gaskets around of the wavelength (depending on the SE required for the cabinet) such straps or doors and removable panels may be braids provide few EMC benefits, no At frequencies for which the longest required instead (see section 5). To help create a larger local RF Reference and get the benefit of whatever shielding is available from a basic metal cabinet, the

Unit's 'earth' terminal bonded to nearest possible point on RF Reference with the shortest thickest wire or widest strap (where the RF Reference has sufficient CSA to be a protective bonding conductor) Example of RF-bonding the 'earth' wire of a plastic electronic unit **®** Local RF Reference (e.g. zinc-plated backplate) Note: bond shown partially assembled

or metal brackets, should be fitted between using plastic backplate mounting brackets, (see section 2) short wide straps or braids, provide the required RF-bonding methods metal to the metal cabinet at every one of backplate should be RF-bonded metal-toits fixing points. Some cabinets are made connect the backplate to the cabinet wall the backplate and the cabinet to provide and wherever the regular fixings don't RF bonds. Similar RF bonds should wherever cables enter or exit the backplate.

#### electrical/electronic items to the 4.2 RF-bonding insulated RF Reference

earth connections for their mains supply -Some insulated items of equipment, such as 'Double-Insulated' types (according to but even so they might have a 'functional earth' that needs to be connected to the cabinet's RF Reference. Insulated items Reference using wires, straps or braids, the safety standards), require no safety can only be connected to the RF

using the shortest practical wires, straps or unctional earths to the local RF Reference. as shown by Figure 42, and this method braids - should be used to connect any protective ('earth') conductors or any Figure 43 illustrates this practice.

insulated item, it cannot be relied upon to MHz, as shown by some of the graphs in 20], so although this method attempts to centimetres of conductor (whether round nas a poor EMC performance (see [14]). achieve good EMC where the item itself completely ineffective (or even counterwire, wide metal strap or braid) can be productive) at frequencies above a few It should be understood that just a few get the best RF performance from an

Shielded cables entering/exiting such items methods described in section 3.7 - unless instructions - but only use pigtails when should have their shields bonded to the understand that the shield performance specifically prohibited in the supplier's local RF Reference using one of the there is no practical alternative, and above 1MHz will then be very poor.

Where there are prohibitions about cable shield bonding, always check whether such suppliers really understand — in EMC terms — why they are making them, in case they are just blindly following the traditional and long-outdated practice of trying to avoid 'ground loops', see section 3.7.1 (and 2.6.8 in the 2006 version of [28]).

# 4.3 RF-bonding metal-bodied electrical/electronic items to the RF Reference

This section assumes the metal-bodied items have highly conductive surface platings (e.g. bright or dull tin, alochromed aluminium, etc.). Where they are painted or anodised or otherwise insulated, it is assumed that the insulating coatings are removed, and a highly-conductive corrosion-resistant paint applied (e.g. paint highly loaded with silver, zinc or aluminium specifically intended for creating conductive surfaces). If none of the above applies — or if bonding to an external metal chassis is specifically prohibited in the supplier's instructions — treat the item as an insulated item, see section 4.2 and expect similar

Where suppliers prohibit bonding the body of a unit, always check whether they understand why — in EMC terms, in case they are just blindly following the traditional and outdated practice of trying to avoid 'ground loops' (see section 3.7.1, and 2.6.8 in the 2006 version of [28]).

Items that employ conductively plated metal bodies often have better EMC performance than ones with painted, anodised or insulating bodies. They also provide more opportunities for improving their EMC by bonding their metal bodies to the RF Reference. So if there is a choice of electronic units for a particular function, and there appears to be nothing to choose

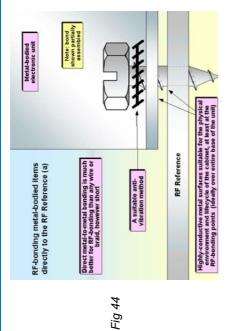
between the EMC performances offered by their manufacturers, it should be best to choose the one with the conductively plated metal body.

Direct metal surface-to-metal surface electrical bonds give the best performance at radio frequencies above 1MHz or so, and should be used to bond all the metal fixings on any electronic units to their local RF Reference as shown by Figures 44 and 45 (also see Figure 7 for comparison).

Where the fixings for a metal-bodied unit are further apart than 100mm or so, adding more RF bonds between its metal case and the RF Reference will generally improve EMC. Ideally, low-profile metal brackets (with highly conductive surface plating) would be screwed between the item's metal body and the RF Reference – but this is not usually acceptable because it could damage the item or invalidate its warranty. Acceptable alternatives include making additional RF bonds with pieces of conductive gasket (see Figure 8) or metal spring fingers (see Figure 9).

Figure 46 shows an example of a 55kW variable-speed motor drive installation in a cabinet. The mains filter, DC power supply and variable speed drive are each in tinplated boxes and each is RF-bonded to the tin-plated backplate using the method shown in Figures 44 and 45. Compare this assembly with Figure 23, and notice also that the motor cable's shield is RF-bonded with a saddleclamp type of fixing to a wide bracket extending from the drive's chassis (its RF Reference).

Modular units such as Programmable Logic Controllers (PLCs) consist of a basic chassis (or some other name) into which the modules are plugged. This chassis should be treated as described in sections 4.2 or 4.3, depending on whether its body is insulated or not.



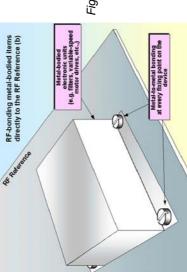
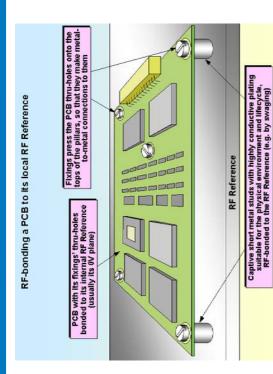


Fig 45



Fig 46



#### 4.4 RF-bonding PCBs to the RF Reference

Ideally, PCBs would be contained within conductively-plated boxes and be treated as described in section 4.3. But sometimes cabinets use unenclosed PCBs, especially if they have been custom-designed for the cabinet manufacturer. Figure 47 shows the general principles of bonding a PCB's own RF Reference (usually its 0V plane) to the cabinet's RF Reference. The bonding points should be spread over the whole PCB area, and within it too, ideally spaced less than  $\lambda/10$  apart at the highest frequency to be controlled.

Of course, this PCB bonding should not be done if specifically forbidden by the PCB supplier – but you should always check whether they really understand in EMC terms why they are making this prohibition, because they might just be blindly following the traditional and long-outdated practice of trying to avoid 'ground loops' (see section 3.7.1, and section 2.6.8 in the 2006 version of [28]).

The PCB-to-Reference bonding points do not have to be fixing screws, they could use the modified clip-on mounting posts shown in Figure 48, or spring fingers such as those in Figure 9. Some manufacturers (e.g. Kitagawa) make spring fingers specifically intended for surface mounting and soldering on PCBs, for making additional RF bonds to their local RF Reference.

### 4.5 Capacitive and hybrid RF-bonding

Sometimes there are very good reasons why it is undesirable to make direct metal-to-metal connections between an electrical/electronic item (including PCBs) and its local RF Reference. In such cases RF-bonding can still be achieved using capacitors in series with each bond. Where there is a single direct bond, and the other bonds are capacitive, this is known as hybrid RF-bonding.

Capacitive and hybrid bonding was described in section 3.7.2, for bonding



cable shields to the RF Reference, and exactly the same issues and capacitor selection issues apply when using these techniques for RF-bonding electrical/electronic items including PCBs.

When designing a PCB that requires capacitive or hybrid bonding, for an industrial cabinet, the series capacitors should be mounted on the board in series with the bonding points — with their traces and pads designed to minimise their inductances, to help achieve the best EMC performance.

### 4.6 Combining safety bonding with RF-bonding

In many industrial cabinets it is often easy to combine the safety and RF-bonding structures together, as shown in sections 4.1, 4.2 and 4.3. This saves time, improves EM performance, and also removes bundles of green/yellow wires from the plastic trunking — making more space and easing the wiring of the cabinet.

However, where 'earth-faults' could result in very heavy currents to a protectively bonded part, the CSA of the cabinet structure might not be sufficient to allow its use in the protective bonding system. Also, some safety inspectors might be uncomfortable if they cannot see green/yellow wires, straps or braids to a 'main earthing bar' from most/all of the protectively bonded structural parts and items of equipment.

Where the RF Reference cannot be used as the protective bonding system, both the RF Reference system and the 'traditional' protective conductor system should exist in parallel, creating a lot of 'ground loops'. In such cases we do not care how long the protective bonding conductors are, as long as RF-bonding system uses the shortest wires, straps and braids (preferably direct metal-to-metal bonds where practical). Of course, this creates a great many 'ground loops', but as was shown in section 2.6.8 of the 2006 version of [28], ground loops are generally a *good* thing for signals,

EMC and safety – providing the electronics is competently designed and there are a large number of small loops and not just one or two large ones.

# 4.7 Choosing filters and bonding them to the RF Reference

#### 4.7.1 Choosing filters

manufacturers). Merely using the  $50\Omega/50\Omega$ attenuation curves can result in amplifying so it is important to choose the right ones than the worst-case derived from all of its mains filter, it is safest to assume that its  $100\Omega/0.1\Omega$ , and  $0.1\Omega/100\Omega$  performance many types of mains filter, and there are attenuation at any frequency is no better 'asymmetrical' and 'symmetrical' by filter an unwanted noise frequency instead of also a great many types of signal filter for your applications. When choosing a As Figure 21 showed, there are a great matched 50Ω/50Ω, and its mismatched differential-mode (known instead as data for both common-mode and attenuating it. Good filter manufacturers will provide all the above data as graphs covering the whole frequency range of interest, including both the conducted range (down to 150kHz or less) and the radiated frequency range (e.g. up to 1GHz or more). For more on these and other filter selection issues refer to [29] (especially its sections 3.2.8, 3.2.9 and 3.3.3) and also to [32].

It is also worth noting that the best filters for EMC have seamless metal bodies fitted with flanges or other means of directly bonding them metal-to-metal to a local RF Reference at least at two points.

#### 4.7.2 Bonding filters to the RF Reference

Some filters rely solely on ferrites and have no need for any connection to the RF Reference. This type includes the cable chokes shown in Figure 20, and they are especially useful where a good quality RF Reference is not available at the frequency to be controlled.

However, most types of filters – and all medium or high-performance filters – contain capacitors, and it is vital for their EMC performance that their highly conductive metal bodies are bonded metal-to-metal to a local RF Reference that has lower impedance than their capacitors at the frequencies of concern. The bonds must be made at least at all of their fixing points, as shown in Figures 44 and 45 and described in section 4.3.

Many types of connectors are available with built-in filters, some of which are simple ferrites needing no Reference connection, some are simple capacitors, and some (more costly) types use Tee or Pi filter pins.

To help protect the electronics in a product from external EM disturbances, the filters fitted to external cables should be fitted at the point where the cable first crosses the boundary of the local RF Reference. But to help reduce interference *inside* a cabinet caused by the emissions from a noisy electrical/electronic unit, filters should be fitted to that unit's local RF Reference as close as possible to it.

Where filters must be used for both the above purposes (typical of the mains and motor drive cables associated with a variable-speed AC motor drive), their location in a cabinet can be a difficult compromise — so it is generally best to locate the noisy unit close to the edge of

the RF Reference, and in the appropriate This is orientation, so that the filter can be other to mounted very close to the noisy unit and RF cur also close to the edge of the Reference current where the filtered cable enters or exits.

for industrial cabinets - and kept close to popular IEC320 plug-inlet style, so that no external mains cable that enters a cabinet Filters fitted to the incoming mains supply should be placed so that the length of is minimised, preferably less than 150mm products should use a bulkhead mounted mains filter if at all possible, such as the meet all the requirements in the relevant cabinet at all. Mains filters fitted prior to terminals must be provided (be sure to the RF Reference at all times. Smaller when the power is switched off at the industrial cabinets) will stay live even appropriate safety warnings for their on/off switches (or door isolators in external mains wires penetrate the product, so touch protection and safety standards).

Filter input and output wires must never come anywhere near each other, as they are always at least one cable Class apart (see section 3.3). Cascaded mains filters can interact and make the overall EMC performance worse than that of each filter on its own, as discussed in the 2006 version of [29], so if it is necessary to cascade filters on a single cable the additional filter might have to have more stages, and be larger with a higher specification, than might seem necessary.

## 4.8 A single connector panel is best

It is best to provide a single connector panel for each cabinet, so that all external cables enter or exit the RF Reference in one place at one of its sides or edges.

This is so that (in conjunction with the other techniques described here) the CM RF currents (sometimes called surface currents) that can flow in long external cables, especially in some electrically noisy industrial environments or during thunderstorms, will flow from cable to cable via the connector panel or edge of the RF Reference through the shield terminations and filters mounted in that

described in section 5.2 as if the connector cables are either filtered or shielded at the panel was part of a shielded cabinet. This is because the external cables' circulating gives best results when all of the external significantly improve immunity to external CM currents generated inside the cabinet, EM threats, and it can also help contain CM currents will then prefer not to flow connector panel, using the techniques The single connector panel technique electronics and their cables. This can through the rest of the cabinet or RF point where they pass through the Reference, or through the internal significantly improving emissions.

### 4.9 RF-bonding VGA display panels to the RF Reference

VGA LCD panel displays are often used in modern industrial cabinets, but can be a significant source of emissions. If they have touchscreens, they can be a problem for immunity. The usual technique is to purchase types that have a continuous metal back cover that is electrically bonded all around its periphery to their metal 'picture frame' surround. Then the VGA panel's metal surround is RF-bonded metal-to-metal (or with a conductive gasket) to the door or wall of the metal cabinet, which should be a part of the RF Reference of the cabinet. This method can

# 5 Using shielded cabinets

#### 55

be seen as a variant of the Clean Box / Dirty Box method described in section

and RF-bonded all around its periphery to the panel's metal 'picture frame' surround, be made from thin metal (or copper tape) using conductive adhesive or conductive around its periphery as described above. metal backs are not suitable, one should gaskets. Then the new back or the LCD If the VGA panels that have complete panel's metal surround is bonded all

If the above is not sufficient, a shielded window will be required - see section

#### 5.1 Introduction

Sections 2, 3 and 4 above assumed that a or cabinet was available and was used as a local RF Reference, but did not assume that the cabinet was designed specifically metal chassis, backplate, racking system, to provide any special shielding performance.

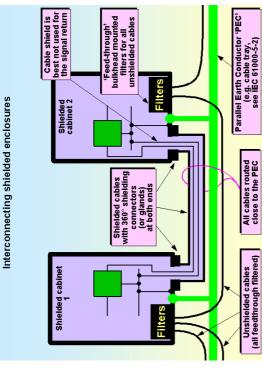
electronic units used inside the cabinet, or emissions from the electrical or electronic environment at the intended operational However, in some applications shielded because the external EM environment cabinets are needed because the EM ocation could be too severe for the needs to be protected from the EM units in the cabinet.

effectively). Very careful attention to detail shielding provided by the cabinet is not to Cabinet shielding requires metal cabinets, or plastic cabinets with highly conductive in design and assembly is needed if the conductive fillers is very difficult to use metal-coated surfaces (plastic with be ruined. There are two issues:

- cabinet, at the point of penetration of conductors entering or exiting the the cabinet wall, see section 5.2 Shielding and/or filtering of all
- doors, removable panels, displays and Control of all apertures, including at ventilation, see section 5.3

The details associated with the design and assembly of shielded enclosures of all sizes are covered in [30]

Fig 49



#### 5.2 Shielding and/or filtering of all conductors entering or exiting the cabinet

EMC performance can be purchased from Shielded cabinets complete with shielded completely ruined by cutting apertures for a number of suppliers, and can easily be door-mounted units, drilling holes, poor whilst section 5.3 covers apertures and This section covers cable penetrations, windows and ventilation with excellent filter mounting, poor cable shielding or shield bonding, or leaving doors open.

to this rule for any conductors of any type, the cabinet wall. There are no exceptions bonded to the cabinet wall (or floor, rear, etc.) at the exact point of penetration of whether they are fibre-optic draw wires; metal pipes or flexible pipes with metal cabinet must be either shielded and/or filtered with the shield and/or filter RF-All conductors entering or exiting a

penetrations are illustrated in Figure 49. general principles of controlling cable pneumatics; cable armour, etc. The strengthening for hydraulics or

and Figure 3). They pick-up EM noises on radiate them on the other sides - thereby sides. The mouse signals themselves are not generally a cause of emissions - the completely ruined by something as trivial like any other conductor (see section 1.4 as a mouse cable penetrating one of its conductors are accidental antennas just defeating the expensive shielding of the t is common to find the SE of a cabinet either side of the cabinet wall and reproblem is that the mouse cable cabinet.

#### entering/exiting a shielded cabinet 5.2.1 Shielded cables

when shielded cables penetrate a shielded engineering practices required to be used Figure 50 shows the good EMC cabinet wall.

Fig 50

Highly conductive plated surface metal-to-metal bonded to shells of connectors and glands

Oxidation and galvanic corresion should be taken into account to maintain SE over the lifecycle despite the physical environment

May need to use conductive gaskets to achieve 360° bonds for rectangular connectors such as D-types

Section of the wall of the shield cabinet connectors in this example)

Chassis-mounted connectors

Chassis-mounted connectors

Shielded cabinet Example of a 360° Shield-clamping cable gland

The metal bodies of the chassis-mounted connectors or glands must make multiple metal-to-metal contacts with the wall of the shielded cabinet, at the point where they pass through it to connect to the cablemounted connectors. The RF-bonding techniques for the cable shields in the cable-mounted connectors were described in 3.7.4 and Figures 27-30. It is very important to ensure that the cabinet has a highly conductive plating that is suitable for the physical environment and lifecycle of the cabinet (see section 6) at least in the areas where the connectors or glands are to be installed.

Circular connectors and glands generally make a good 360° electrical bond all around their cabinet aperture. However, rectangular connectors generally only achieve reliable RF bonds at their mounting points (two, for a D-Type) and where high values of SE are required, or where frequencies above 100MHz are to be controlled, they should be fitted with a

conductive gasket during assembly to achieve a good RF-bond all around their perimeters. A number of manufacturers make EMC gaskets for different types of chassis-mounted connector, such as those shown in Figure 51.

Saddle-clamps, P-clips, pigtails and any other shield bonding method that cannot achieve a 360° electrical bond around the aperture required for the connector or gland in the cabinet wall, must not be used to bond cable shields as they enter/exit a shielded cabinet. The only exceptions to this might perhaps be in very special circumstances where the shielded cabinet is not required to shield against frequencies above, say, 100kHz (and even then, pigtails are not recommended).

# 5.2.2 When good shielding practices contradict supplier's instructions

It sometimes happens that two items of equipment are installed in separate shielded cabinets, and need to be

Some examples of gaskets for non-ideal shielded connectors

Spring finger gaskets for Delype connectors (Feuerherdt GmbH)

Metallised fabric over foam gaskets for Delype connectors (AMP Inc.)

Spring finger gaskets for Bering finger gaskets for Delypes (Feuerherdt GmbH)

interconnected by a shielded cable – but one of the equipment is supplied with EMC instructions that state that its cable shield must only be connected at one end (usually at that item of equipment, and usually to a screw-terminal or connector pin). Leaving aside the issues of whether the supplier had used good EMC design, or was simply regurgitating 'traditional' instructions that are now decades obsolete – unless the supplier can be persuaded to alter his EMC instructions they should be followed or else they will disclaim all responsibility for interference.

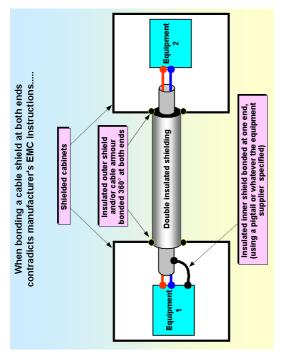
The problem is that unless the shield is RF-bonded to the walls of both shielded cabinets, following the equipment supplier's instructions to bond the shield at only one end will fatally compromise their shielding performance. Figure 52 illustrates one solution — use a double insulated shield cable and RF-bond the outermost insulated shield to both the shielded cabinets in the approved manner

(see section 5.2.1). The insulated inner shield can then be terminated in accordance with the supplier's EMC instructions.

Where both equipment suppliers insist that the cable shield must only be bonded at one end, and they don't agree on which end, the method of Figure 52 will preserve the SE of the cabinets, but cannot resolve the problem of which end to bond the inner shield.

# 5.2.3 Unshielded cables entering/exiting a shielded cabinet

Every unshielded cable that enters or exits a shielded cabinet must be fitted with a filter that provides a similar level of RF attenuation versus frequency as the SE required for the cabinet. This filter must be mounted at the point where the cable penetrates the metal (or metallised) wall of the cabinet, and must make multiple metal-to-metal electrical bonds at that point.



'Through-bulkhead' filters and filtered connectors cause the least degradation of a cabinet's SE, as long as their metal bodies make multiple metal-to-metal bonds to the cabinet wall all around the perimeter of their cut-outs, as illustrated in Figure 53. Many cabinets have had their SE ruined by a lack of provision of metal-to-metal bonding of IEC 320 appliance-inlet filters.

Where modest levels of SE are required from the cabinet, it may be enough to rely on the bonds provided by the fixings of the filter, but for good SE — especially at frequencies above 100MHz — a conductive gasket may be required to bond the filter's metal body to the cabinet's metal surface all around its periphery.

Note that Figure 53 does not show the protective cover that would be required for the safety of the high-performance feedthrough filter.

An alternative to is to use a lower cost chassis-mounted filter. These cannot be

ferrite cable suppressers (CM chokes, see technique, especially minimising any gaps used with what is usually called the Clean of high frequencies between the input and installed so that they penetrate the wall of Figure 53. Attention to detail is needed to frequency through-bulkhead filter may still Figure 20) to one or both cables close to cables inside the Dirty Box, especially at the Dirty Box, and reducing the coupling in the RF-bonding around the edges of frequencies above 100MHz, so a highcables that enter or exit a cabinet they degrade its SE. However, they can be coupling between the input and output sufficiently by adding one or more soft keeping them short and far away from need to be fitted to one of the cables. a shielded cabinet, so when used on Box / Dirty Box method, as shown in output cables inside the Dirty Box by Often, this coupling can be reduced achieve high values of SE with this each other. There will still be some he Dirty Box.

#### <u></u> IEC 320 appliance -inlet bulkhead -mounted Clean Box = inside the shielded cabinet filter Metal-to-metal bonds required betweer the filters' metal bodies and the wall of the shielded cabinet Mounting filters in the walls of shielded cabinets High-performance feedthrough filter rough filter (examples shown are all power filters) 4 Dirty Box Completely encloses filter, with frequent metal-to-metal bonds or conductive gasket to the shield wall Input and output wires short, and far apart from each other Chassis- & mounted & mains filter & May need a high-frequency feedthrough filter (maybe just a CM ferrite) here, and/or here. $\times \times \times \times$

'Room filters' are chassis-mounting filters specifically designed for penetrating the walls of shielded cabinets without compromising their SE. They incorporate compartmented shields for their input and output terminals (effectively two separate Dirty Boxes), and their filtered outputs enter the shielded room through galvanised conduit with 360° bonding to the wall of the room, as shown in Figure 54.

Room filters are available from a number of manufacturers, suitable for every type of signal or electrical power. They are generally designed to achieve attenuations of at least 80dB from 100kHz to at least 1GHz, and types are available that go down to kHz and/or up to 40GHz and meet military specifications. Room filters can also be fitted to industrial cabinets, and are generally required when a shielded cabinet needs to have the highest EMC performance.

### 5.2.4 A segregated cabinet

Figure 55 shows a shielded cabinet that has been segregated into 'clean' and 'dirty' volumes, using the methods described above for terminating cable shields and screw-terminal filters. Instead of dividing a cabinet, some designers bring their cables into a small Dirty cabinet that is bolted (preferably seamwelded) to the side of the Clean cabinet.

# 5.2.5 A single connector panel is still the best

The benefits described for a single connector panel in section 4.8 also apply in the case of a shielded cabinet, because the internal and external circulating CM currents ('surface currents') do not have to cross any joints or gaps in metal surfaces, and this helps keep the internal currents inside, and the external currents outside – just what we want for good emissions and immunity respectively.

Mounting 'room filters' to The wall of the walls of shielded rooms the shielded room filter's shielded to wall of shielded room filter's shielded enclosure bonded 360" metal-to-metal to room filter's shielded enclosure hetal conduit or cable shield shields the cable for at least a few metres

An example of a Clean Box / Dirty Box segregated shielded cabinet

Clean Box (the shielded with a line and the connectors andrough backplate, racking system, or card-frame backplate, racking system, or card-frame connectors androughlitered in the same of the state of the state

Shield gaps are 'accidental slot antennas'

Usually negligible antenna effects accidental antenna facts and antenna effects accidental antenna facts and ant

# 5.3 Controlling apertures and gaps in shielded cabinets

#### 5.3.1 Introduction

Fig 55

Shielded cabinets complete with shielded windows and ventilation with excellent EMC performance can be purchased from a number of suppliers, and can easily be completely ruined by cutting apertures for door-mounted units, drilling holes, poor filter mounting, poor cable shielding or shield bonding, or leaving doors open. Section 5.2 covered the shielding and/or filtering of all cable penetrations, whilst this section covers apertures and gaps.

Apertures and gaps in a shielded cabinet generally act as 'accidental slot antennas' as shown by Figure 56, much as conductors act as accidental antennas as shown by Figure 3. It does not matter how narrow a gap is (even as thin as a layer of paint or anodising), or even if it is shaped like a labyrinth and there is no line of sight

through it – it still leaks RF energy and degrades the cabinet's SE. Having accidental slot antennas in the wall of a shielded cabinet compromises its SE.

[30] describes good shielding practices for cabinets, and goes into detail on apertures and other issues that will not be repeated here.

### 5.3.2 Displays and controls

Figure 57 shows how to use the Clean Box / Dirty Box method where an item (such as a display, meter or control) has to penetrate the wall of a shielded cabinet. It is important to note that the item in the Dirty Box does not benefit from the shielding of the cabinet, so must have emissions and immunity performance that is adequate given the external EM environment.

Much better EMC is achieved by placing displays behind shielded windows,

Fig 57

Cabinet door

Cabinet box

Completely encloses

Cabinet bod (inside of shielded

Cabinet bod (inside of shielded)

Cabinet bod

especially with VGA-type LCD panels, and this can be important where a good SE is needed or higher frequencies are to be controlled.

Shielded windows use very fine blackened metal meshes, or conductively-plated layers (often indium tin oxide, known as ITO), sandwiched between two clear plastic panels, and the metal mesh or plated layer must be metal-to-metal bonded to the display's cut-out in the shielded wall all around the perimeter of the display. Figure 58 shows a shielded window that has just been manufactured, before the excess mesh has been removed. They are all designed so that the mesh is exposed around the four sides so that it can be 360° bonded to the shield

Figure 59 shows some example figures for the SE achieved by some types of shielded window materials. Note that these are for the materials themselves,

measured under ideal conditions. In practice the dominant factors for a cabinet's SE are usually the design of their assembly, and the quality of the workmanship when they are assembled in the cabinet. Metal mesh windows generally give better shielding performance than conductive coatings, for a given level of optical transmission loss and degradation of visibility, but can suffer from Moiré fringing effects if not selected carefully to suit the pixel size of the display. All shielded windows make the display look dimmer, so backlights may need to be more powerful.

Touchscreens behind shielded windows are possibly a good EMC solution to the problem of adding human-machine interfaces to shielded cabinets, although some touchscreen technologies can be difficult to use with a shielded window.

'Honeycomb metal' can also be used for shielding displays, and has excellent SE

Example of a mesh-shielded window, before assembly (from TBA-ECP)

(from TBA-ECP)

(from TBA-ECP)

(from TBA-ECP)

values but has an extremely limited viewing angle. This can be very useful in security applications, because it makes it almost impossible for anyone to see a display unless they are right in front of it, but this is not a desirable feature in industrial applications.

#### 5.3.3 Ventilation

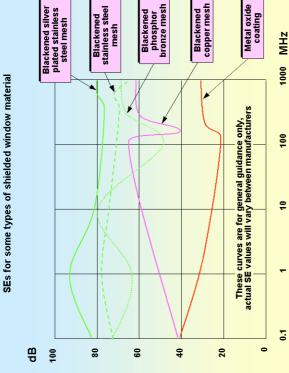
Ventilation apertures can be shielded by fitting a wire mesh (welded at each wire crossover in the mesh) over the aperture, with each wire electrically bonded metal-to-metal to the wall of the shielded cabinet all around the periphery of the cut-out in the cabinet wall. The smaller the mesh size, the better the SE. Perforating the cabinet wall with a number of small slots or holes can achieve the same SE and ventilation as fitting a wire grille over a large aperture, and avoids the need to provide RF bonding around the periphery of a wire mesh.

A number of shielding manufacturers sell pre-assembled shielding grilles that may simply be fitted with a conductive gasket all around their edges and then bolted into place on the cabinet wall (which of course must be highly conductive over the required bonding area). Some of these are based on wire mesh, and some on more exotic technologies such as wire wool or 'honeycomb metal' to give better SEs, and some examples are shown in Figure 60.

A technique known as 'waveguide below cutoff' can provide very high values of SE with very little impedance to the airflow. This technique is described in detail in [30], and honeycomb metal ventilation panels are an example of its application.

### 5.3.4 Doors and removable panels

To achieve useful SEs, apertures in an cabinet must be few in number and small in size, so doors and removable panels must have frequent electrical bonds all around their edges. Bonding them with



Blackened silver plated stainless steel mesh mesh phosphor bronze mesh bronze mesh copper mesh

wires or straps is no good at all above a few MHz. Figure 61 shows details of the bonding of the doors and removable panels using a volume-conductive elastomer gasket (such as neoprene loaded with silver-plated glass beads).

A selection of shielded air vents (from Chomerics)

Fig 60

EMC gaskets are available that provide environmental as well as EMC sealing. Gaskets and their contact areas must not be painted, and careful choices of materials and metal plating finishes are needed to ensure good EMC, and prevent corrosion, over the lifecycle of the cabinet (see section 6).

Very many different types of gaskets and spring fingers are available from a number of manufacturers. Gasket choice requires balancing many physical considerations, such as compliance, compression set, and position in the galvanic series, with electrical ones such as contact resistance. An opening door may require a soft gasket (for ease of manual closing) that always springs back to its original shape, but

RF-bonding the doors and removable panels on shielded cabinets

| Highly conductive plated metal surface under the gasket all around the door or panel

these are often difficult to combine with low contact resistance. Spring fingers ('finger stock') are often used around doors and removable panels, as shown in Figure 62, but are quite fragile and in some applications could easily be damaged.

## 5.4 The effective use of gaskets

This guide does not discuss gaskets and their use in any detail, except to say that when assembled they should be compressed to an amount within their manufacturers recommended range – and this can require considerable pressure. As mentioned in 2.5, even EMC gaskets that can easily be squashed flat between two fingers can require very large compression forces overall when used in long strips, so the effective use of gaskets requires careful mechanical and fixing design to prevent metal parts from bending too much in delivering those forces.

It is not unusual to fit strips of very soft conductive gaskets to the door of an

# 6 Preventing galvanic corrosion

Fig 62

**67** 



becomes almost impossible to close, and opening up large gaps that defeat the once closed it bends like a banana industrial cabinet, only to find that it purpose of the gasketting.

probes applied with a very light pressure, to coating - as they sometimes seem to. It is easy to design and make a probe based on 'accidentally' applied a polymer passivation above text and figures that gaskets require always recommended that metal parts are supplier, before being accepted into store. highly-conductive metal surfaces to make Such tests should use very blunt, smooth checked for the conductivity of any EMCa battery, buzzer and two smooth spring-It has been mentioned many times in the related surfaces when delivered by their loaded contacts, that can be used like a connection on both of their sides. It is rubber stamp to de-skill metal surface discover whether the supplier has conductivity checking at goods-in.

EMC gaskets must continue to be effective over the lifecylce of the cabinet despite exposure to the physical

installed. This includes such issues as: environment at the site where it is

- Mechanical (e.g. shock and vibration)
- Climatic (e.g. air temperature, pressure and humidity)
- condensation, liquids, sprays, mists, vapours and dusts of various types) Chemical (e.g. exposure to
- Biological (e.g. mould growth)
- Wear and tear from normal use, cleaning, maintenance, etc.

design to achieve the correct compression Good EMC gasket manufacturers provide the correct choice of gasket materials and real possibility, and should be avoided by into account their physical environments, without distortion of the cabinet or any of gaskets or the plating they bond to is a assistance (for example [27]), covering styles for particular applications, taking and the data required for mechanical its parts. Galvanic corrosion of the following the guidance in section 6. a wealth of data and application

All of the techniques described above rely cabinet, despite its physical environment. for their effectiveness on achieving very The contact resistance at each RF bond galvanic corrosion - the subject of this oxidation of the metals used, or due to must not be permitted to increase too much over the lifecycle, either due to connections over the lifecycle of the low-impedance metal-to-metal

Different metals have different positions in battery' and a self-generated current flows connection very quickly indeed, maybe in liquid (called an electrolyte, for example connected by an electrically-conductive ordinary water) they form an 'accidental in them. The most anodic of the metals eventually disappearing (or turning into the electro-chemical series, so when corrosion products) altogether. If the environment, galvanic corrosion can non-conductive or semi-conductive gets eaten away by this current, completely destroy an electrical choice of metals is poor for the ust a few weeks.

simulated lifecycle test using standard Figure 63 shows an example of a metal blanks to test the galvanic compatibility of different types of conductive EMC gasket.

preventing galvanic corrosion, which is [20] has a very good chapter on summarised very briefly below.

Classification of metals by their position in he galvanic series:

More anodic (most easily corroded) -Group 1 Magnesium

Group 2 Aluminium and its alloys,

zinc, cadmium

Group 3 Carbon steel, iron, lead, tin, tin-lead solder Group 4 Nickel, chromium, stainless

Group 5 Copper, silver, gold, platinum, titanium more cathodic (least easily corroded)

whilst material C had After a 144-hour salt spray accelerated life test... gasket material A had very poor shielding effectiveness (SE), B had poor SE, Example of a test comparing simulated lifecycle corrosion for three different gasket types 8

#### Group 4 Group 4 Group 5 Group 5 Cathode end Group 5 Group 4 Corrosion guidance (adapted from NAVAIR 115, 1988) Group 3 Group 3 Group 3 Group 2 Group 2 Group 1 | Group 2 | Group 3 | Group 4 Anode end (most heavily corroded) Housed Housed Housed Exposure situation Sheltered Sheltered Sheltered Sheltered Exposed Exposed Exposed

A: Metal may be exposed at junction surfaces, rest given appropriate protective coat C: Protective coatings are mandatory. Even so, only has a short life B: Coating must prevent any possibility of liquid bridging the join

- Make sure the part more likely to be corroded is easily replaced.
- Can sometimes fit a sacrificial washer or strap (higher in the series than either side of the bond, so corrodes first) as long as regular maintenance prevents excessive

identical compositions) are used in contact. used in contact with each other regardless group are low enough to allow them to be differences between the materials in each aggressive environments (such as the identical metals (or, if they are alloys, of the environment. However, in very probably best to make sure that only The idea is that the galvanic voltage deck of an ocean-going vessel) it is

protected from the electrolyte, preventing underneath the plating to get eaten away. quality of the plating. A pinhole or scratch Coating or plating mating parts with the nickel) helps keep the dissimilar metals galvanic corrosion, but depends on the same metal (for example, zinc, tin, or in the plating can allow the metal

Figure 64 is a useful table giving guidance environment, and was extracted from [20]. on the combinations of the metals in the above five groups, depending on their

The flow of DC or AC current through an containing electrical/electronic circuits. corrosion, making it a more important electrical bond also hastens galvanic consideration for industrial cabinets

material that sublimes, releasing a vapour prevent electrical bonds from being made insulating film just a few molecules thick. between different parts, but sufficient to prevent oxidation or galvanic corrosion. recently developed technology [33] that claims to use small quantities of a solid The film is supposed to be too weak to Vapour-phase corrosion inhibition is a that coats nearby metal parts with an

1] European Union Directive 89/336/EEC version of the current EMC Directive and guidance document on how to apply the Compatibility. The Directive's official EU standards listed under the Directive; a http://europa.eu.int/comm/enterprise/ homepage includes a downloadable its successor; a table of all the EN (as amended) on Electromagnetic electr\_equipment/emc/index.htm. Directive; lists of appointed EMC Competent Bodies; etc., all at:

The new European Union Directive 2004/108/EC on Electromagnetic Compatibility (2nd Edition): nttp://europa.eu.int/eur-lex/lex/LexUri Serv/site/en/oj/2004/I\_390/I\_3902004 1231en00240037.pdf See [2] for details of the transition from 89/336/EEC to 2004/108/EC.

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documents on complying with the EMC 'Publications and Downloads' pages at [5] A number of useful and practical Directive are available from the www.cherryclough.com

Electrical, Electronic and Programmable [6] IEC 61508: "Functional Safety of Electronic Systems" (seven parts)

0 /

7] IEC 61511: "Functional safety: Safety instrumented systems for the process 'ndustry sector"

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12] "EMC Testing", a series in six parts by published in the EMC Compliance Journal Publications and Downloads' pages at during 2001-2, and available via the im Williams and Keith Armstrong, www.cherryclough.com

(www.emctla.co.uk) Technical Guidance 13] "On-Site EMC Test Methods", Keith Armstrong, EMC Test Labs Association Publications and Downloads' pages at Note No. TGN 49, available from the www.cherryclough.com

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www.iee.org.uk/Library, libdesk@iee.org.uk [17] "Achieving EMC Directive Compliance with a Spreadsheet", Keith Armstrong, Conformity, February 2006, from the archives at www.conformity.com [18] IEC 61000-5-2:1997 "Electromagnetic Compatibility (EMC) — Part 5: Installation and Mitigation Guidelines — Section 2: Earthing and cabling"

[19] PD IEC TR 61000-5-6:2002
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Installation and mitigation guidelines —
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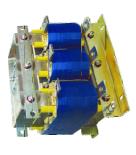
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involved controlling real-life interference majoring in analogue circuit design and -aude). Much of his life since then has Keith Armstrong graduated in electrical systems, and installations, for a variety problems in high-technology products, engineering with a B.Sc (Hons.) from of companies and organisations in a Jpper Second Class Honours (Cum electromagnetic field theory, with a mperial College London in 1972, range of industries.

European Engineer since 1988, and has of the IEE's Professional Group (E2) on and chairs the IEE's Working Group on papers on EMC. He is a past chairman Keith has been a Chartered Electrical Engineer (UK) since 1978, a Group 1 member of the IEEE's EMC Society, written and presented a great many Electromagnetic Compatibility, is a EMC and Functional Safety'.

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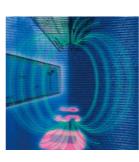
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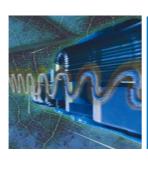
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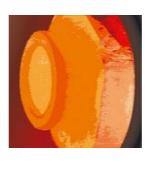
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